

# UCS2112

## **USB Dual-Port Power Switch and Current Monitor**

#### Features

- Dual-Port Power Switches:
  - 2.9V to 5.5V source voltage range
  - 3.0A continuous current per  $V_{BUS}$  port with 40 m $\Omega$  On resistance per switch
  - Independent port power switch enable pins
  - DUAL fault ALERT# active drain output pins
  - Constant Current or Trip mode current limiting behaviors
  - Undervoltage and overvoltage lockout
  - Back-drive, back-voltage protection
  - Auto-recovery fault handling with low test current
  - BOOST# logic output to increase DC-DC converter output under large load conditions
  - A\_DET# open-drain outputs for device attach detection per port
- SMBus 2.0/I<sup>2</sup>C Mode Features:
  - Eight programmable current limits assignable to each power switch
  - Other SMBus addresses available upon request
  - Block read and block write
- Self-contained current monitoring (no external sense resistor required)
- Fully programmable per-port charge rationing and behaviors
- Per-port BC1.2 V<sub>BUS</sub> Discharge Function
- Wide Operating Temperature Range:
- -40°C to +105°C
- UL recognized and EN/IEC 60950-1 (CB) certified.

#### Description

The UCS2112 is a dual USB port power switch configuration which can provide 3.0A continuous current (3.4A maximum) per  $V_{BUS}$  port with precision overcurrent limiting (OCL), port power switch enables, auto-recovery fault handling, undervoltage and overvoltage lockout, back-drive protection and back-voltage protection, and dynamic thermal management.

The UCS2112 is well suited for both stand-alone and applications having SMBus/I<sup>2</sup>C communications.

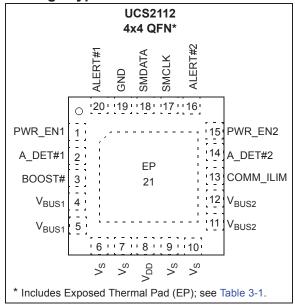
For applications with SMBus, the UCS2112 provides per-port current monitoring and eight programmable current limits per switch, ranging from 0.53A to 3.0A continuous current (3.4A maximum). Per-port charge rationing is also provided ranging from 3.8 mAh to 246.3 Ah.

In Stand-alone mode, the UCS2112 provides eight current limits for both switches, ranging from 0.53A + 0.53A to 3A + 3A total continuous current (see Table 1-1).

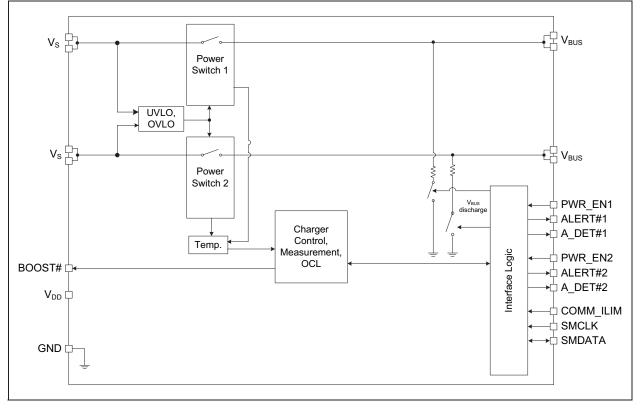
Both power switches include an independent  $V_{\text{BUS}}$  discharge function and constant current mode current limiting for BC1.2 applications.

The UCS2112 is available in a 4x4 mm 20-pin QFN package.

#### Package Type



### **Block Diagram**



### 1.0 ELECTRICAL CHARACTERISTICS

#### Absolute Maximum Ratings †

Voltage on $V_{DD}$ , $V_S$ , and $V_{BUS}$ pins	0.3 to +6V
Pull-Up Voltage (V <sub>PULLUP</sub> )	0.3 to V <sub>DD</sub> + 0.3
Port Power Switch Current	Internally limited
Voltage on any Other Pin to Ground	0.3 to V <sub>DD</sub> + 0.3V
Current on any Other Pin	±10 mA
Package Power Dissipation	See Table 1-1
Operating Ambient Temperature Range	40°C to +105°C
Storage Temperature Range	55°C to +150°C

**† Notice:** Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

Board	Package	θ <b></b> JC	$\theta_{JA}$	De-Rating Factor above +25°C	T <sub>A</sub> < +25°C Power Rating	T <sub>A</sub> = +70°C Power Rating	T <sub>A</sub> = +85°C Power Rating
High K (Note 1)	20-pin QFN 4x4 mm	6 °C/W	41 °C/W	24.4 mW/°C	2193 mW	1095 mW	729 mW
Low K (Note 1)	20-pin QFN 4x4 mm	6 °C/W	60 °C/W	16.67 mW/°C	1498 mW	748 mW	498 mW

#### TABLE 1-1: POWER DISSIPATION SUMMARY

**Note 1:** A High K board uses a thermal via design with the thermal landing soldered to the PCB ground plane with 0.3 mm (12 mil) diameter vias in a 3x3 matrix (9 total) at 0.5 mm (20 mil) pitch. The board is multi-layer with 1-ounce internal power and ground planes and 2-ounce copper traces on top and bottom. A Low K board is a two-layer board without thermal via design with 2-ounce copper traces on the top and bottom.

#### TABLE 1-2: ELECTRICAL SPECIFICATIONS

<b>Electrical Characteristics:</b> Unless otherwise specified, $V_{DD}$ = 4.5V to 5.5V, $V_{S}$ = 2.9V to 5.5V,
$V_{PULLUP}$ = 3V to 5.5V, $T_A$ = -40°C to 105°C. All typical values at $V_{DD}$ = $V_S$ = 5V, $T_A$ = 27°C.

Characteristic	Symbol	Min.	Тур.	Max.	Unit	Conditions
Power and Interrupts – DC						
Supply Voltage	V <sub>DD</sub>	4.5	5	5.5	V	
Supply Current in Active (I <sub>DD_ACT</sub> + I <sub>S1_ACT</sub> + I <sub>S2_ACT</sub> )	I <sub>ACTIVE</sub>	_	850		μA	Average current I <sub>BUS</sub> = 0 mA
Supply Current in Sleep (I <sub>DD_SLEEP</sub> + I <sub>S1_SLEEP</sub> + I <sub>S2_SLEEP</sub> )	I <sub>SLEEP</sub>	—	6	20	μA	Average current $V_{PULLUP} \le V_{DD}$
Supply Current in Detect (I <sub>DD_DET</sub> + I <sub>S1_DET</sub> + I <sub>S2_DET</sub> )	IDETECT	—	200		μA	Average current No portable device attached (Note 1)

**Note 1:** This parameter is characterized, not 100% tested.

**2:** This parameter is ensured by design and not 100% tested.

### TABLE 1-2: ELECTRICAL SPECIFICATIONS (CONTINUED)

Electrical Characteristics: U V <sub>PULLUP</sub> = 3V to 5.5V, $T_A = -4$					-	
Characteristic	Symbol	Min.	Тур.	Max.	Unit	Conditions
Power-on Reset	• 	•	•		·	
V <sub>DD</sub> Low Threshold	V <sub>DD_TH</sub>	—	4	—	V	V <sub>DD</sub> voltage increasing
V <sub>DD</sub> Low Hysteresis	V <sub>DD_TH_HYST</sub>	—	500	600	mV	V <sub>DD</sub> voltage decreasing (Note 1)
I/O Pins - SMCLK, SMDATA	, PWR_EN, ALE	RT#, A_	DET#, E	BOOST# -	DC Par	ameters
Output Low Voltage	V <sub>OL</sub>	_	_	0.4	V	I <sub>SINK_IO</sub> = 8 mA SMDATA, ALERT#, A_DET#, BOOST#
Input High Voltage	V <sub>IH</sub>	2.0		_	V	PWR_EN, SMDATA, SMCLK
Input Low Voltage	V <sub>IL</sub>	_	—	0.8	V	PWR_EN, SMDATA, SMCLK
Leakage Current	I <sub>LEAK</sub>	_	—	±5	μA	Powered or unpowered $V_{PULLUP} \le V_{DD}$ T <sub>A</sub> < 85°C (Note 1)
Interrupt Pins – AC Parame	eters					
ALERT# Pin Blanking Time	t <sub>BLANK</sub>	—	25		ms	Blanking time, coming out of Reset
ALERT# Pin Interrupt Masking Time	t <sub>MASK</sub>	_	5	_	ms	
BOOST# Pin Minimum Assertion Time	t <sub>BOOST_MAT</sub>	_	1	_	S	
BOOST# Pin Assertion Current	I <sub>BOOST</sub>	—	1.9	_	A	
SMBus/I <sup>2</sup> C Timing	•		•			
Input Capacitance	C <sub>IN</sub>	_	5	_	pF	
Clock Frequency	f <sub>SMB</sub>	10	_	400	kHz	
Spike Suppression	t <sub>SP</sub>	_		50	ns	
Bus Free Time Stop to Start	t <sub>BUF</sub>	1.3	_		μs	
Start Setup Time	t <sub>SU:STA</sub>	0.6	_		μs	
Start Hold Time	t <sub>HD:STA</sub>	0.6			μs	
Stop Setup Time	t <sub>SU:STO</sub>	0.6	_	_	μs	
Data Hold Time	t <sub>HD:DAT</sub>	0			μs	When transmitting to the master
Data Hold Time	t <sub>HD:DAT</sub>	0.3	_	_	μs	When receiving from the master
Data Setup Time	t <sub>SU:DAT</sub>	0.6	—		μs	
Clock Low Period	t <sub>LOW</sub>	1.3	—		μs	
Clock High Period	t <sub>HIGH</sub>	0.6	—		μs	
Clock / Data Fall Time	t <sub>FALL</sub>		_	300	ns	Min = 20+0.1C <sub>LOAD</sub> ns (Note 1)
Clock / Data Rise Time	t <sub>RISE</sub>	_	_	300	ns	Min = 20+0.1C <sub>LOAD</sub> ns (Note 1)

Note 1: This parameter is characterized, not 100% tested.

**2:** This parameter is ensured by design and not 100% tested.

### TABLE 1-2: ELECTRICAL SPECIFICATIONS (CONTINUED)

**Electrical Characteristics:** Unless otherwise specified,  $V_{DD} = 4.5V$  to 5.5V,  $V_S = 2.9V$  to 5.5V,  $V_{PULLUP} = 3V$  to 5.5V,  $T_A = -40^{\circ}$ C to 105°C. All typical values at  $V_{DD} = V_S = 5V$ ,  $T_A = 27^{\circ}$ C.

Characteristic	Symbol	Min.	Тур.	Max.	Unit	Conditions
Capacitive Load	C <sub>LOAD</sub>	—	—	400	pF	Per bus line (Note 1)
Timeout	t <sub>TIMEOUT</sub>	25	_	35	ms	Disabled by default (Note 1)
Idle Reset	t <sub>IDLE_RESET</sub>	350	—		μs	Disabled by default (Note 1)
Port Power Switch		1	II		1	
	Port Po	wer Sw	itch – Do	C Parame	eter	
Overvoltage Lockout	V <sub>S_OV</sub>		6	_	V	Note 2
V <sub>S</sub> Low Threshold	V <sub>S_UVLO</sub>		2.5		V	Note 2
V <sub>S</sub> Low Hysteresis	V <sub>S_UVLO_HYST</sub>	—	100		mV	Note 2
On Resistance	R <sub>ON_PSW</sub>	—	40	60	mΩ	4.75V < V <sub>S</sub> < 5.25V
V <sub>S</sub> Leakage Current	I <sub>LEAK_VS</sub>		_	5	μA	Sleep state into V <sub>S</sub> pin on one channel (Note 1)
Back-Voltage Protection Threshold	V <sub>BV_TH</sub>	—	150	—	mV	$V_{BUS} > V_{S}$ $V_{S} > V_{S_{UVLO}}$
Back-drive Current	I <sub>BD_1</sub>	_	0	3	μA	$V_{DD} < V_{DD_TH}$ , Leakage current from $V_{BUS}$ pins to the $V_{DD}$ and the $V_S$ pins (Note 1)
	I <sub>BD_2</sub>		0	2	μA	$V_{DD} > V_{DD_TH}$ , Leakage current from $V_{BUS}$ pins to the $V_{DD}$ (in Detect State) or the $V_S$ pins (in Active State) (Note 1)
Selectable Current Limits	I <sub>LIM1</sub>	—	530	_	mA	I <sub>LIM</sub> Resistor = 0 or 47 kΩ (530 mA setting)
	I <sub>LIM2</sub>	—	960	—	mA	$I_{LIM}$ Resistor = 10 k $\Omega$ or 56 k $\Omega$ (960 mA setting)
	I <sub>LIM3</sub>		1070		mA	$I_{LIM}$ Resistor = 12 k $\Omega$ or 68 k $\Omega$ (1070 mA setting)
	I <sub>LIM4</sub>	—	1280	—	mA	$I_{LIM}$ Resistor = 15 k $\Omega$ or 82 k $\Omega$ (1280 mA setting)
	I <sub>LIM5</sub>	_	1600	—	mA	$I_{LIM}$ Resistor = 18 kΩ or 100 kΩ (1600 mA setting)
	I <sub>LIM6</sub>	—	2130	_	mA	$I_{LIM}$ Resistor = 22 k $\Omega$ or 120 k $\Omega$ (2130 mA setting)
	I <sub>LIM7</sub>	2500	2670	2900	mA	$I_{LIM}$ Resistor = 27 k $\Omega$ or 150 k $\Omega$ (2670 mA setting)
	I <sub>LIM8</sub>	3000	3200	3400	mA	$I_{LIM}$ Resistor = 33 k $\Omega$ or V <sub>DD</sub> (3200 mA setting)
Pin Wake Time	t <sub>PIN_WAKE</sub>	_	3		ms	
SMBus Wake Time	t <sub>SMB_WAKE</sub>		4	_	ms	

**Note 1:** This parameter is characterized, not 100% tested.

**2:** This parameter is ensured by design and not 100% tested.

### TABLE 1-2: ELECTRICAL SPECIFICATIONS (CONTINUED)

**Electrical Characteristics:** Unless otherwise specified,  $V_{DD} = 4.5V$  to 5.5V,  $V_S = 2.9V$  to 5.5V,  $V_{PULLUP} = 3V$  to 5.5V,  $T_A = -40^{\circ}$ C to 105°C. All typical values at  $V_{DD} = V_S = 5V$ ,  $T_A = 27^{\circ}$ C.

Characteristic	Symbol	Min.	Тур.	Max.	Unit	Conditions
Idle Sleep Time	t <sub>IDLE_SLEEP</sub>		200		ms	
Thermal Regulation Limit	T <sub>REG</sub>	_	110		°C	Die Temperature at which current limit will be reduced
Thermal Regulation Hysteresis	T <sub>REG_HYST</sub>		10		°C	Hysteresis for t <sub>REG</sub> functionality. Temperature must drop by this value before I <sub>LIM</sub> value restored to normal operation
Thermal Shutdown Threshold	T <sub>TSD</sub>	_	135	_	°C	Die Temperature at which port power switch will turn off
Thermal Shutdown Hysteresis	T <sub>TSD_HYST</sub>	_	35		°C	After shutdown due to T <sub>TSD</sub> being reached, die temperature drop required before port power switch can be turned on again
Auto-Recovery Test Current	I <sub>TEST</sub>	—	190	—	mA	Portable device attached, V <sub>BUS</sub> = 0V, Die temp < T <sub>TSD</sub>
Auto-Recovery Test Voltage	V <sub>TEST</sub>	_	750	_	mV	Portable device attached, $V_{BUS}$ = 0V before application, Die temp < T <sub>TSD</sub> Programmable, 250 - 1000 mV, default listed
Discharge Impedance	R <sub>DISCHARGE</sub>	_	100		W	
	Port Pov	wer Swi	tch – AC	Parame	ters	
Turn-On Delay	t <sub>on_psw</sub>	_	200		ms	Depends on the V <sub>BUS</sub> Discharge setting. Programmable 100 – 400 ms, default listed
Turn-Off Time	t <sub>off_psw_ina</sub>	—	0.75	_	ms	PWR_EN inactive toggle to switch off time C <sub>BUS</sub> = 120 μF
Turn-Off Time	t <sub>OFF_PSW_ERR</sub>	—	1		ms	Over-current Error, V <sub>BUS</sub> Min Error, or Discharge Error to switch off C <sub>BUS</sub> = 120 µF
Turn-Off Time	t <sub>OFF_PSW_ERR1</sub>	—	100	_	ns	TSD or Back-drive Error to switch off C <sub>BUS</sub> = 120 µF
V <sub>BUS</sub> Output Rise Time	t <sub>R_BUS</sub>	—	1.1		ms	Measured from 10% to 90% of $V_{BUS}$ , $C_{LOAD}$ = 220 µF $I_{LIM}$ = 1.0A
Soft Turn-On Rate	$\Delta I_{BUS} / \Delta_t$	_	100	_	mA/µs	
Temperature Update Time	t <sub>DC_TEMP</sub>		200		ms	

**Note 1:** This parameter is characterized, not 100% tested.

2: This parameter is ensured by design and not 100% tested.

#### TABLE 1-2: ELECTRICAL SPECIFICATIONS (CONTINUED)

**Electrical Characteristics:** Unless otherwise specified,  $V_{DD} = 4.5V$  to 5.5V,  $V_S = 2.9V$  to 5.5V,  $V_{PULLUP} = 3V$  to 5.5V,  $T_A = -40^{\circ}$ C to 105°C. All typical values at  $V_{DD} = V_S = 5V$ ,  $T_A = 27^{\circ}$ C.

$V_{\text{PULLUP}} = 3V \text{ to } 5.5V, I_{\text{A}} = -4$		typical v	alues at	$v_{DD} = v_S$	= 5V, 1 <sub>A</sub>	= 27 C.
Characteristic	Symbol	Min.	Тур.	Max.	Unit	Conditions
Short-Circuit Response Time	t <sub>SHORT_LIM</sub>	_	1.5	—	μs	Time from detection of short to current limit applied. No C <sub>BUS</sub> applied
Short-Circuit Detection Time	t <sub>short</sub>	_	6	_	ms	Time from detection of short to port power switch disconnect and ALERT# pin assertion.
Latched Mode Cycle Time	t <sub>UL</sub>	_	7	_	ms	From PWR_EN edge transition from inactive to active to begin error recovery
Auto-Recovery Mode Cycle Time	t <sub>cycle</sub>		25	_	ms	Time delay before error condition check Programmable 15-50 ms, default listed
Auto-Recovery Delay	t <sub>TST</sub>	_	20		ms	Portable device attached, $V_{BUS}$ must be $\geq V_{TEST}$ after this time Programmable 10-25 ms, default listed
Discharge Time	<sup>t</sup> discharge	_	200	_	ms	Amount of time discharge resistor applied Programmable 100-400 ms, default listed
Port	Power Switch C	Operatio	n With T	rip Mode	Current	Limiting
Region 2 Current Keep-out	I <sub>BUS_R2MIN_1</sub>	-	—	0.1	A	Note 2
Minimum V <sub>BUS</sub> Allowed at Output	V <sub>BUS_MIN_1</sub>	2.0	—	—	V	Note 2
Port Power	Switch Operatio	n With C	onstant	Current	Limiting	(Variable Slope)
Region 2 Current Keep-out	I <sub>BUS_R2MIN</sub>	—	_	2.13	A	Note 2
Minimum V <sub>BUS</sub> Allowed at Output	V <sub>BUS_MIN</sub>	2.0	—	—	V	Note 2
	Cu	rrent Me	asurem	ent – DC		
Current Measurement Range	I <sub>BUS_M</sub>	0	_	3400	mA	Range (Note 2 and Note 3)
Reported Current Measurement Resolution	$\Delta I_{BUS_M}$		13.3	—	mA	1 LSB
Current Measurement			±2		%	200 mA < I <sub>BUS</sub> < I <sub>LIM</sub>
Accuracy		—	±2	—	LSB	I <sub>BUS</sub> < 200 mA

Note 1: This parameter is characterized, not 100% tested.

2: This parameter is ensured by design and not 100% tested.

### TABLE 1-2: ELECTRICAL SPECIFICATIONS (CONTINUED)

Electrical Characteristics: $V_{PULLUP}$ = 3V to 5.5V, $T_A$ =						
Characteristic	Symbol	Min.	Тур.	Max.	Unit	Conditions
	Cu	rrent Me	asurem	ent – AC		·
Sampling Rate	—	_	1.1	_	ms	Note 2
Conversion Time both channels	t <sub>CONV</sub>	_	2.2	—	ms	All registers updated in digital (Note 2)
	C	harge R	ationing	– DC	•	•
Accumulated Current Measurement Accuracy	-	—	±4.5	_	%	
	C	harge R	ationing	– AC		
Current Measurement Update Time	t <sub>PCYCLE</sub>	_	1	—	S	
Attach / Removal Detection	on				•	
		V <sub>BUS</sub> B	ypass –	DC		
On Resistance	R <sub>ON_BYP</sub>		45	_	Ω	
Leakage Current	I <sub>LEAK_BYP</sub>		—	3	μA	Switch off T <sub>A</sub> < +85°C (Note 1)
Current Limit	I <sub>DET_CHG</sub> / I <sub>BUS_BYP</sub>	_	500	_	μA	$V_{DD}$ = 5V and $V_{BUS}$ > 4.75V
V <sub>BUS</sub> Charge Time for Attachment	t <sub>DET_CHARGE</sub>	—	800	_	ms	C <sub>BUS</sub> = 500 μF maximum
	Attac	h/Remov	al Deteo	ction – D	С	•
Attach Detection Threshold	IDET_QUAL	_	800	—	μA	Programmable 200-1000 μA, default listed
Primary Removal Detection Threshold	I <sub>REM_QUAL_ACT</sub>	_	700	_	μA	Programmable 100-900 μA, default listed. Active power state
	I <sub>REM_QUAL_DET</sub>	_	800	_	μA	Programmable, default listed. Detect power state
	Attacl	h/Remov	al Deteo	ction – A	С	
Attach Detection Time	<sup>t</sup> DET_QUAL		100	_	ms	Time from Attach to A_DET# assert.
Removal Detection Time	t <sub>REM_QUAL</sub>		1000		ms	

**Note 1:** This parameter is characterized, not 100% tested.

2: This parameter is ensured by design and not 100% tested.

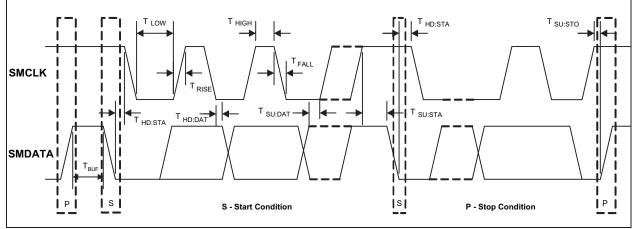


FIGURE 1-1: SMBus Timing.

#### TABLE 1-3: TEMPERATURE SPECIFICATIONS

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions			
Temperature Ranges									
Operating Temperature Range	T <sub>A</sub>	-40	—	+105	°C				
Operating Junction Temperature	TJ	-40	—	+125	°C				
Storage Temperature Range T <sub>A</sub> -55 — +150 °C									
Thermal Package Resistances – see Table 1-1.									

#### 1.1 ESD and Transient Performance

#### TABLE 1-4:ESD RATINGS

ESD Specification	Rating or Value
Human Body Model (JEDEC JESD22-A114) – All pins	8 kV
Charged Device Model (JEDEC JESD22-C101) – All pins	500V

#### 1.1.1 HUMAN BODY MODEL (HBM) PERFORMANCE

HBM testing verifies the ability to withstand ESD strikes like those that occur during handling and manufacturing and is done without power applied to the IC. To pass the test, the device must have no change in operation or performance due to the event.

#### 1.1.2 CHARGED DEVICE MODEL (CDM) PERFORMANCE

CDM testing verifies the ability to withstand ESD strikes like those that occur during handling and assembly with pick and place style machinery and is done without power applied to the IC. To pass the test, the device must have no change in operation or performance due to the event. NOTES:

### 2.0 TYPICAL PERFORMANCE CURVES

Note: Unless otherwise indicated,  $V_{DD} = V_S = 5V$ ,  $T_A = +27^{\circ}C$ .

**Note:** The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

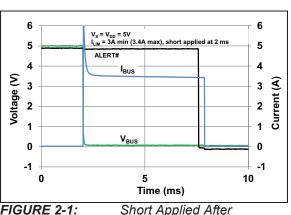


FIGURE 2-1: Power-Up.

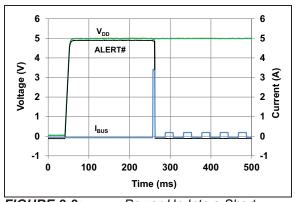
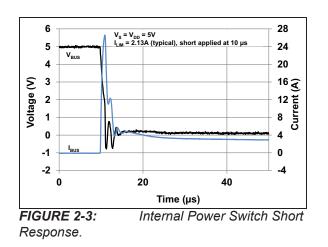


FIGURE 2-2: Power-Up Into a Short.



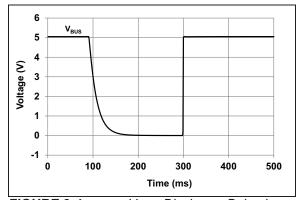


FIGURE 2-4:

V<sub>BUS</sub> Discharge Behavior.

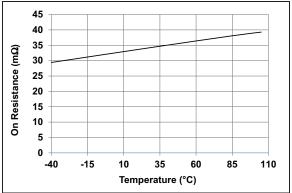
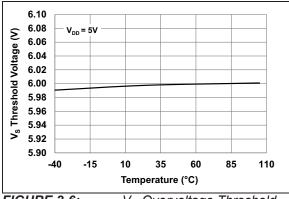


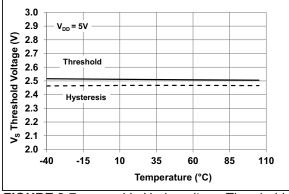
FIGURE 2-5: Power Switch On Resistance vs. Temperature.

## UCS2112

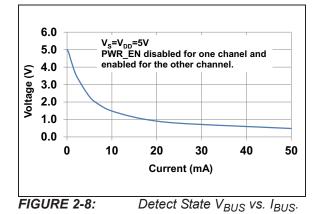
Note: Unless otherwise indicated,  $V_{DD}$  =  $V_S$  = 5V,  $T_A$  = +27°C.

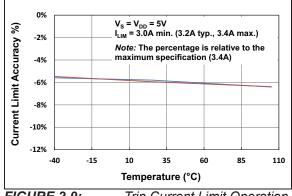


**FIGURE 2-6:** V<sub>S</sub> Overvoltage Threshold vs. Temperature.

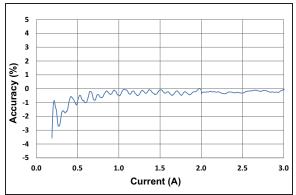


**FIGURE 2-7:** V<sub>S</sub> Undervoltage Threshold vs. Temperature.

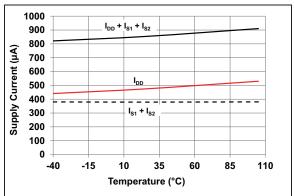




**FIGURE 2-9:** Trip Current Limit Operation vs. Temperature.

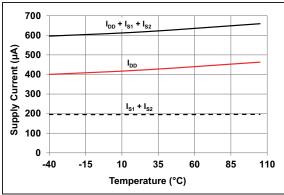


*FIGURE 2-10: I<sub>BUS</sub> Measurement Accuracy.* 

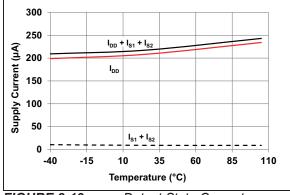


**FIGURE 2-11:** Active State Current vs. Temperature (both channels on, PWR EN1 = PWR EN2 = 1).

Note: Unless otherwise indicated,  $V_{DD} = V_S = 5V$ ,  $T_A = +27^{\circ}C$ .



**FIGURE 2-12:** Active State Current vs. Temperature (only one channel on, *PWR\_EN1* = 1, *PWR\_EN2* = 0).



**FIGURE 2-13:** Detect State Current vs. Temperature.

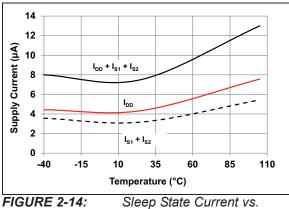
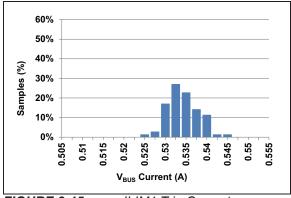
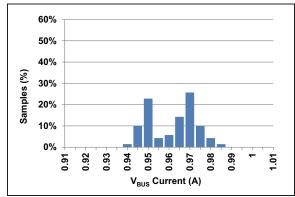


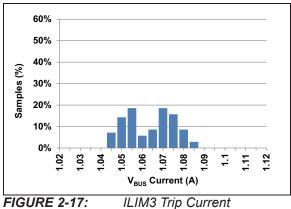
FIGURE 2-14: Temperature.



**FIGURE 2-15:** ILIM1 Trip Current Distribution.



**FIGURE 2-16:** ILIM2 Trip Current Distribution<sup>(1)</sup>.

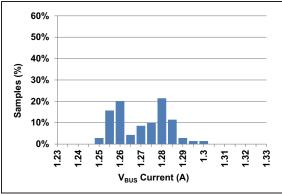


Distribution<sup>(1)</sup>.

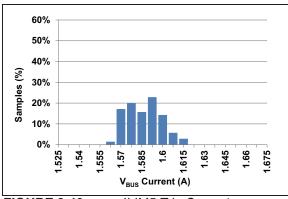
Note 1: The histogram aspect is caused by a mixture of two normal distributions, corresponding to the two V<sub>BUS</sub> channels.

## UCS2112

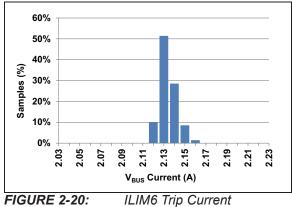
Note: Unless otherwise indicated,  $V_{DD} = V_S = 5V$ ,  $T_A = +27^{\circ}C$ .



**FIGURE 2-18:** ILIM4 Trip Current Distribution<sup>(1)</sup>.



**FIGURE 2-19:** ILIM5 Trip Current Distribution<sup>(1)</sup>.



Distribution.

Note 1: The histogram aspect is caused by a mixture of two normal distributions, corresponding to the two  $V_{BUS}$  channels.

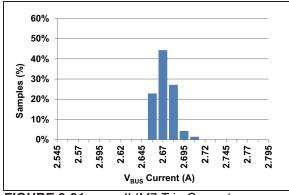


FIGURE 2-21: ILIM7 Trip Current Distribution.

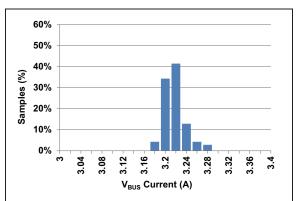


FIGURE 2-22: ILIM8 Trip Current Distribution.

### 3.0 PIN DESCRIPTION

Descriptions of the pins are listed in Table 3-1.

#### TABLE 3-1: PIN FUNCTION TABLE

UCS2112 4x4 QFN Symbol		Function	Pin Type	Connection Type if Pin Not Used
1	PWR_EN1	Port power switch enable #1	DI	Connect to ground or V <sub>DD</sub> (depending on the polarity decoded via COMM_ILIM pin)
2	A_DET#1	Open-drain output for Attach Detection on $V_{BUS1}$ (requires pull-up resistor)	OD	Connect to ground
3	BOOST#	Logic output for DC-DC converter voltage increase (requires pull-up resistor)	OD	Connect to ground
4, 5	V <sub>BUS1</sub>	Port power switch #1 output (requires both pins tied together)	High Power, AIO	Leave open
6, 7	V <sub>S</sub>	Voltage input to port power switch $V_{\text{BUS1}}$ (requires both pins tied together)	High Power, AIO	Connect to ground
8	V <sub>DD</sub>	Common supply voltage	Power	N/A
9, 10	V <sub>S</sub>	Voltage input to port power switch $V_{BUS2}$ (requires both pins tied together)	High Power, AIO	Connect to ground
11, 12	V <sub>BUS2</sub>	Port power switch #2 output (requires both pins tied together)	High Power, AIO	Leave open
13	COMM_ILIM	Enables SMBus or Stand-Alone mode at power-up. Hardware strap for maximum current limit	AIO	N/A
14	A_DET#2	Open-drain output for Attach Detection on V <sub>BUS2</sub> (requires Pull Up)	OD	Connect to ground
15	PWR_EN2	Port power switch enable #2	DI	Connect to ground or V <sub>DD</sub> (depending on the polarity decoded via COMM_ILIM pin)
16	ALERT#2	Output fault ALERT for V <sub>BUS2</sub> (requires pull-up resistor)	OD	Connect to ground
17	SMCLK	SMCLK - SMBus clock input (requires pull-up resistor)	DI	Connect to V <sub>PULLUP</sub> (or to ground in Stand-alone mode)
18	SMDATA	SMDATA - SMBus data input/output (requires pull-up resistor)	DIOD	Connect to V <sub>PULLUP</sub> (or to ground in Stand-alone mode)
19	GND	Ground	Power	N/A
20	ALERT#1	Output fault ALERT for V <sub>BUS1</sub> (requires pull-up resistor)	OD	Connect to ground
21	EP	Exposed thermal pad. Must be connected to electrical ground.	EP	N/A

#### TABLE 3-2:PIN TYPES

Pin Type	Description
Power	This pin is used to supply power or ground to the device.
Hi-Power	This pin is a high-current pin.
AIO	Analog Input/Output – this pin is used as an I/O for analog signals.
DI	Digital Input – this pin is used as a digital input.
DIOD	Open-Drain Digital Input/Output – this pin is bidirectional. It is open-drain and requires a pull-up resistor.
OD	Open-Drain Digital Output – used as a digital output. It is open-drain and requires a pull-up resistor.
EP	Exposed thermal pad

### 4.0 TERMS AND ABBREVIATIONS

**Note:** The PWR\_EN1 and PWR\_EN2 pins each have Configuration bits ("<pin name>\_S" in General Configuration 1 register (Address 11h) and General Configuration 2 register (Address 12h)) that may be used to perform the same function as the external pin state. These bits are accessed via the SMBus/l<sup>2</sup>C and are OR'd with the respective pin. This OR'd combination of pin state and register bit is referenced as the <pin name> control.

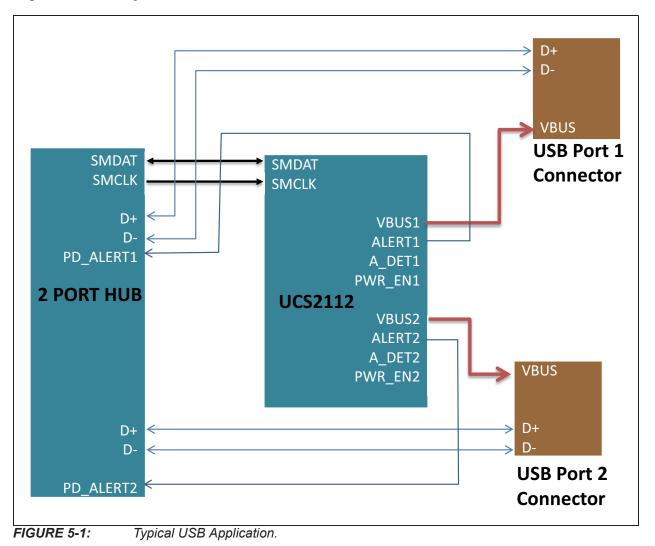
Term/Abbreviation	Description
Attach Detection	An Attach Detection event occurs when the current drawn by a portable device is greater than $I_{DET_QUAL}$ for longer than $t_{DET_QUAL}$ .
Attachment	The physical insertion of a portable device into a USB port that UCS2112 is controlling.
CC	Constant Current
CDM	Charged Device Model. JEDEC model for characterizing susceptibility of a device to damage from ESD.
Current Limiting	Determines the action that is performed when the $I_{BUS}$ current reaches the $I_{LIM}$ threshold. Trip
Mode	opens the port power switch. Constant Current (variable slope) allows $V_{BUS}$ to be dropped by
	the portable device.
Disconnection	USB-IF term which refers to the loss of active USB communications between a USB host and a USB device.
Dynamic Thermal Management	The UCS2112 automatically adjusts port power switch limits and modes to lower internal power dissipation when the thermal regulation temperature value is approached.
НВМ	Human Body Model
I <sub>BUS_R2MIN</sub>	Current limiter mode boundary
I <sub>LIM</sub>	The I <sub>BUS</sub> current threshold used in current limiting. In Trip mode, when I <sub>LIM</sub> is reached, the port power switch is opened. In Constant Current mode, when the current exceeds I <sub>LIM</sub> , operation continues at a reduced voltage and increased current; if V <sub>BUS</sub> voltage drops below V <sub>BUS_MIN</sub> , the port power switch is opened.
OCL	Overcurrent limit
POR	Power-on Reset
Portable Device	USB device attached to the USB port.
Removal Detection	A Removal Detection event occurs when the current load on the V <sub>BUS</sub> pin drops to less than
	I <sub>REM_QUAL</sub> for longer than t <sub>REM_QUAL</sub> .
Removal	The physical removal of a portable device from a USB port that the UCS2112 is controlling.
Stand-Alone Mode	Indicates that the communications protocol is not active and all communications between the UCS2112 and a controller are done via the external pins only (PWR_EN1 and PWR_EN2 as inputs, and ALERT1#, ALERT2#, A_DET1# and A_DET2# as outputs).

TABLE 4-1: TERMS AND ABBREVIATIONS

NOTES:

### 5.0 GENERAL DESCRIPTION

The UCS2112 is a dual-port power switch. Two USB power ports are supported with current limits up to 3.0A continuous current (3.4A maximum) each. Selectable and programmable current limiting configurations are also available to the application. A typical block diagram is shown in Figure 5-1.



#### 5.1 UCS2112 Power States

Power states are indicators of the device's current consumption in the System and the functionality of the Digital Logic. Table 5-1 details the UCS2112 power states.

State	Description
Off	This power state is entered when the voltage at the $V_{DD}$ pin voltage is < $V_{DD_TH}$ . In this state, the device is considered "off". The UCS2112 will not retain its digital states and register contents nor respond to SMBus/I <sup>2</sup> C communications. The port power switch and bypass switch will be off. See Section 5.1.1 "Off State Operation".
Sleep	This is the lowest power state available. While in this state, the UCS2112 will retain digital functionality and wake to respond to SMBus/l <sup>2</sup> C communications. See <b>Section 5.1.2 "Sleep State Operation</b> ".
Detect	The Detect power state should not be confused with the actual Attach / Removal Detection feature. Detect power state is both channels awaiting attachment. This is a lower-current power state. In this state, the device is actively looking for a portable device to be attached. While in this state, the UCS2112 will retain the configuration and charge rationing data, but it will not monitor the bus current. SMBus/I <sup>2</sup> C communications will be fully functional. See Section 5.1.3 "Detect State Operation".
Error	This power state is entered when a Fault condition exists. Error power state is one or both channels in Fault Handling. This state is updated as Priority One. The Interrupt Status registers for each channel will update the fault detected per channel. Only the channel that has detected a fault will be affected since the other channel can remain active if no fault is detected. See Section 5.1.5 "Error State Operation".
Active	Active power state is one, or both channels active and sourcing current to the V <sub>BUS</sub> Port. This state is updated as Priority Two. None of the channels have detected fault. This power state provides full functionality. While in this state, operations include activation of the port power switch, current limiting, and charge rationing. See Section 5.1.4 "Active State Operation".

#### TABLE 5-1: POWER STATES DESCRIPTION

Table 5-2 shows the settings for the various power states, except Off and Error. If  $V_{DD} < V_{DD_TH}$ , the UCS2112 is in the Off state.

#### TABLE 5-2: POWER STATES CONTROL SETTINGS

Power State	PWR_EN1	PWR_EN2	ATT_DET	Portable Device Attached	Behavior
Sleep	disabled	disabled	N/A	N/A	All switches disabled.
					<ul> <li>V<sub>BUS</sub> will be near ground potential.</li> </ul>
					<ul> <li>The UCS2112 wakes to respond to SMBus communications.</li> </ul>
Detect	enabled	disabled	enabled	No	<ul> <li>Automatic transition to Active state when conditions met for V<sub>BUS1</sub> (see Section 5.1.3.1 "Automatic Transition from Detect to Active").</li> </ul>
					<ul> <li>V<sub>BUS2</sub> pins have very low current delivery capability.</li> </ul>
	disabled	enabled	enabled	No	<ul> <li>Automatic transition to Active state when conditions met for V<sub>BUS2</sub> (see Section 5.1.3.1 "Automatic Transition from Detect to Active").</li> </ul>
					<ul> <li>V<sub>BUS1</sub> pins have very low current delivery capability.</li> </ul>
	enabled	enabled	enabled	No	<ul> <li>Automatic transition to Active state when conditions met for both V<sub>BUS1</sub> and V<sub>BUS2</sub> (see Section 5.1.3.1 "Automatic Transition from Detect to Active").</li> </ul>

Power State	PWR_EN1	PWR_EN2	ATT_DET	Portable Device Attached	Behavior
Active	enabled	disabled	N/A	Yes	<ul> <li>Port power switch is on during A_DET1=1 for V<sub>BUS1</sub>.</li> </ul>
					<ul> <li>V<sub>BUS2</sub> pins have very low current delivery capability.</li> </ul>
	disabled	enabled	N/A	Yes	<ul> <li>Port power switch is on during A_DET2=1 for V<sub>BUS2</sub>.</li> </ul>
					<ul> <li>V<sub>BUS1</sub> pins have very low current delivery capability.</li> </ul>
	enabled	enabled	N/A	Yes	<ul> <li>Port power switch is on during A_DET1=A_DET2=1</li> </ul>
					for V <sub>BUS1</sub> and V <sub>BUS2</sub> .
	enabled	disabled	disabled	N/A	<ul> <li>Forced ACTIVE Power State: Port power switch is on at all times for V<sub>BUS1</sub>.</li> </ul>
					<ul> <li>V<sub>BUS2</sub> pins have very low current delivery capability.</li> </ul>
	disabled	enabled	disabled	N/A	<ul> <li>Forced ACTIVE Power State: Port power switch is on at all times for V<sub>BUS2</sub>.</li> </ul>
					<ul> <li>V<sub>BUS1</sub> pins have very low current delivery capability.</li> </ul>
	enabled	enabled	disabled	N/A	<ul> <li>Forced ACTIVE Power State: Port power switch is on at all times for V<sub>BUS1</sub> and V<sub>BUS2</sub>.</li> </ul>

TABLE 5-2: POWER STATES CONTROL SETTINGS (CONTINUED)

#### 5.1.1 OFF STATE OPERATION

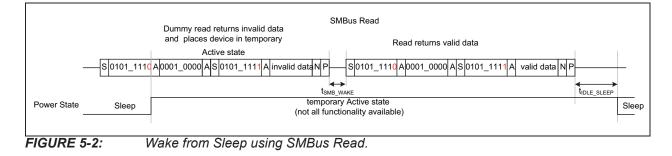
The device will be in the Off state if  $V_{DD}$  is less than  $V_{DD\_TH}$ . When the UCS2112 is in the Off state, it will do nothing and all circuitry will be disabled. Digital register values are not stored and the device will not respond to SMBus commands.

#### 5.1.2 SLEEP STATE OPERATION

The PWR\_EN1 and PWR\_EN2 pins may be used to cause the UCS2112 to enter/exit Sleep. These pins are AND'ed for Sleep mode.

When the UCS2112 is in the Sleep state, the device will be in its lowest-power state. The bypass switch and the port power switch will be disabled. The Attach and Removal Detection feature will be disabled.  $V_{BUS1}$  and  $V_{BUS2}$  will be near ground potential. The ALERT#1 and ALERT#2 pins will not be asserted. If asserted prior to entering the Sleep state, the ALERT# pin will be released. SMBus activity is limited to single byte read or write.

The first data byte read from the UCS2112 when it is in the Sleep state will wake it; however, the data to be read will return all 0's and should be considered invalid. This is a "dummy" read byte meant to wake the UCS2112. Subsequent read or write bytes will be accepted normally. After the dummy read, the UCS2112 will be in a higher-power state (see Figure 5-2). After communication has not occurred for  $t_{\text{IDLE\_SLEEP}}$ , the UCS2112 will return to Sleep.



#### DETECT STATE OPERATION 5.1.3

When the UCS2112 is in the Detect state, the port power switch will be disabled. The V<sub>BUS</sub> output will be connected to the  $V_{DD}$  voltage by a secondary bypass switch.

There are two methods for transitioning from the Detect state to the Active state: automatic and host-controlled.

#### 5.1.3.1 Automatic Transition from Detect to Active

For the Detect state, enable PWR EN1 and/or PWR\_EN2, and supply  $V_{DD} \ge V_{DD}$  TH. When a portable device is attached and an Attach Detection event occurs, the UCS2112 will automatically transition to the Active state.

#### 5.1.3.2 State Change from Detect to Active

When conditions cause the UCS2112 to transition from the Detect state to the Active state, the following occurs:

- The Attach Detection feature will be disabled; the Removal Detection feature remains enabled.
- The bypass switch will be turned off.
- · The discharge switch will be turned on briefly for t<sub>DISCHARGE</sub>.
- · The port power switch will be turned on.

#### 5.1.4 ACTIVE STATE OPERATION

Every time the UCS2112 enters the Active state, the port power switches are closed. The UCS2112 cannot be in the Active state (and therefore, the port power switch cannot be turned on) if any of the following conditions exist:

V<sub>S</sub> < V<sub>S UVLO</sub>

**TABLE 5-3**:

· PWR\_EN1 and PWR\_EN2 are disabled.

#### 5.1.5 ERROR STATE OPERATION

The UCS2112 will enter the Error state from the Active state when any of the following events are detected:

- · The maximum allowable internal die temperature (T<sub>TSD</sub>) has been exceeded.

**COMMUNICATION DECODE** 

- An overcurrent condition has been detected.
- · An undervoltage condition on either V<sub>BUS</sub> pin has been detected (see Section 5.3.4 "Undervoltage Lockout on VS").
- · A back-drive condition has been detected (see Section 5.3.2 "Back-voltage Detection").
- A discharge error has been detected.
- An overvoltage condition on the V<sub>S</sub> pin.

The UCS2112 will enter the Error state from the Detect state when a back-drive condition has been detected on either port, or when the maximum allowable internal die temperature has been exceeded.

The UCS2112 will enter the Error state from the Sleep state when a back-drive condition has been detected.

When the UCS2112 enters the Error state, the port power switch and the V<sub>BUS</sub> bypass switch will be disabled while the ALERT# pin is asserted (by default). They will remain off while in this power state. The UCS2112 will leave this state as determined by the fault handling selection.

With the auto-recovery fault handler, after the t<sub>CYCLE</sub> time period, the UCS2112 will check that all of the error conditions have been removed.

If all of the error conditions have been removed, the UCS2112 will return to the Active state or Detect state, as applicable.

If the device is in the Error state and a Removal Detection event occurs, it will check the error conditions and then return to the power state defined.

#### 5.2 Communication

The UCS2112 can operate in SMBus mode (see Section 8.0 "System Management Bus Protocol") or Stand-alone mode. The resistor connected to the COMM ILIM pin determines the operating mode and the hardware-set I<sub>LIM</sub> setting, as shown in Table 5-3. Unless connected to GND or V<sub>DD</sub>, the resistors in Table 5-3 are external pull-down resistors.

The SMBus address is specified in Section 8.2 "SMBus Address and RD/WR Bit".

COMM_ILIM Pull Down Resistor (±1%)	PWR_EN1 and PWR_EN2 Polarity	I <sub>LIM</sub> (A)	Total I <sub>LIM</sub> (A) (Note 1)	Communication Mode
GND	Active-High	0.53	0.53 + 0.53	SMBus
10 kΩ	Active-High	0.96	0.96 + 0.96	SMBus
12 kΩ	Active-High	1.07	1.07 + 1.07	SMBus
15 kΩ	Active-High	1.28	1.28 + 1.28	SMBus
18 kΩ	Active-High	1.6	1.6 + 1.6	SMBus

**Note 1:** The total maximum current depends on power dissipation characteristics of the design (see Table 1-1).

TABLE 5-3: COMMONICATION DECODE (CONTINUED)							
PWR_EN1 and PWR_EN2 Polarity	I <sub>LIM</sub> (A)	Total I <sub>LIM</sub> (A) (Note 1)	Communication Mode				
Active-High	2.13	2.13 + 2.13	SMBus				
Active-High	2.67	2.67 + 2.67	SMBus				
Active-High	3.2	3.2 + 3.2	SMBus				
Active-Low	0.53	0.53 + 0.53	Stand-Alone				
Active-Low	0.96	0.96 + 0.96	Stand-Alone				
Active-Low	1.07	1.07 + 1.07	Stand-Alone				
Active-Low	1.28	1.28 + 1.28	Stand-Alone				
Active-Low	1.6	1.6 + 1.6	Stand-Alone				
Active-Low	2.13	2.13 + 2.13	Stand-Alone				
Active-Low	2.67	2.67 + 2.67	Stand-Alone				
Active-Low	3.2	3.2 + 3.2	Stand-Alone				
	PWR_EN1 and         PWR_EN2 Polarity         Active-High         Active-High         Active-High         Active-Low         Active-Low	PWR_EN1 and PWR_EN2 PolarityILIM (A)Active-High2.13Active-High2.67Active-High3.2Active-Low0.53Active-Low0.96Active-Low1.07Active-Low1.28Active-Low1.6Active-Low2.13Active-Low2.67	PWR_EN1 and PWR_EN2 Polarity         ILIM (A)         Total ILIM (A) (Note 1)           Active-High         2.13         2.13 + 2.13           Active-High         2.67         2.67 + 2.67           Active-High         3.2         3.2 + 3.2           Active-Low         0.53         0.53 + 0.53           Active-Low         0.96         0.96 + 0.96           Active-Low         1.07         1.07 + 1.07           Active-Low         1.28         1.28 + 1.28           Active-Low         1.6         1.6 + 1.6           Active-Low         2.13         2.13 + 2.13				

TABLE 5-3: COMMUNICATION DECODE (CONTINUED)

Note 1: The total maximum current depends on power dissipation characteristics of the design (see Table 1-1).

#### 5.3 Supply Voltages

#### 5.3.1 V<sub>DD</sub> SUPPLY VOLTAGE

The UCS2112 requires 4.5V to 5.5V present on the  $V_{DD}$  pin for core device functionality. Core device functionality consists of maintaining register states, wake-up upon SMBus/I<sup>2</sup>C query and Attach Detection.

#### 5.3.2 BACK-VOLTAGE DETECTION

The back drive detector is functional in all power states (Sleep, Detect, and Active).

When in Sleep, the UCS2112 will enter the Error state from Sleep if a Back Drive condition was detected.

Whenever the following condition is true for either port, the port power switch will be disabled, the  $V_{BUS}$  bypass switch will be disabled and a back-voltage event will be flagged. This will cause the UCS2112 to enter the Error power state (see Section 5.1.5 "Error State Operation").

**Note:** The V<sub>BUS</sub> voltage exceeds the V<sub>S</sub> and/or the V<sub>DD</sub> pin voltage by V<sub>BV\_TH</sub> and the port power switch is closed. The port power switch will be opened immediately. If the condition lasts for longer than  $t_{MASK}$ , then the UCS2112 will enter the Error state. Otherwise, the port power switch will be turned on as soon as the condition is removed.

#### 5.3.3 BACK-DRIVE CURRENT PROTECTION

If a portable device is attached that is self-powered, it may drive the V<sub>BUS</sub> port to its power supply voltage level; however, the UCS2112 is designed such that leakage current from the V<sub>BUS</sub> pins to the V<sub>DD</sub> and/or the V<sub>S</sub> pin shall not exceed I<sub>BD\_1</sub> (if the V<sub>DD</sub> and/or V<sub>S</sub> voltage is zero) or I<sub>BD\_2</sub> (if the V<sub>DD</sub> and/or V<sub>S</sub> voltage exceeds V<sub>DD\_TH</sub>).

#### 5.3.4 UNDERVOLTAGE LOCKOUT ON V<sub>S</sub>

The UCS2112 requires a minimum voltage ( $V_{S_UVLO}$ ) be present on the  $V_S$  pin for Active power state.

## 5.3.5 OVERVOLTAGE DETECTION AND LOCKOUT ON V<sub>S</sub>/V<sub>DD</sub>

The UCS2112 port power switch will be disabled if the voltage on the V<sub>S</sub> pin exceeds a voltage (V<sub>S\_OV</sub>) for longer than the specified time ( $t_{MASK}$ ). This will cause the device to enter the Error state.

#### 5.3.6 PWR\_EN1 AND PWR\_EN2 INPUT

The PWR\_EN control affects the power state and enables the port power switch to be turned on if conditions are met (see Table 5-2). The port power switch cannot be closed if PWR\_EN is disabled. However, if PWR\_EN is enabled, the port power switch is not necessarily closed (see Section 5.1.4 "Active State Operation"). In SMBus mode, the PWR\_EN1 and PWR\_EN2 pins states will be ignored by the UCS2112 if the PIN\_IGN Configuration bit is set; otherwise, the PWR\_EN1S and PWR\_EN2S Configuration bits are checked along with the pins.

#### **Discrete Output Pins** 5.4

#### 5.4.1 ALERT#1 AND ALERT#2 OUTPUT PINS

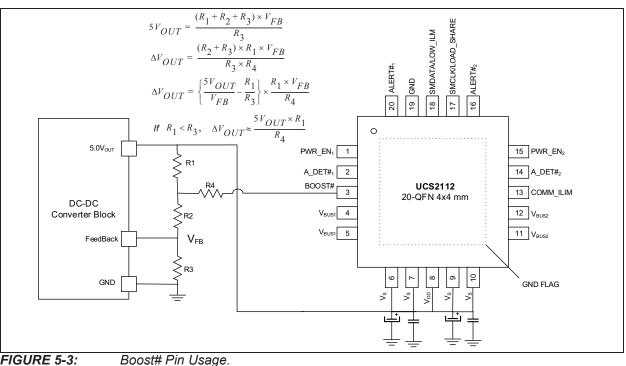
The UCS2112 has two independent ALERT# out pins. ALERT#1 is tied to the status of the V<sub>BUS1</sub> pin. ALERT#2 is tied to the status of the V<sub>BUS2</sub> pin.

The ALERT# pin is an active-low open-drain interrupt to the host controller. The ALERT# pin is asserted when an error occurs. The ALERT# pin can also be asserted when the LOW CUR (portable device is pulling less current and may be finished charging) or TREG (thermal regulation temperature exceeded) bits are set and linked. Also, when charge rationing is enabled, the ALERT# pin is asserted by default when the current rationing threshold is reached (as determined by RTN BEH<1:0>). The ALERT# pin is released when all error conditions that may assert the ALERT# pin (such as an error condition, charge rationing, and TREG and LOW CUR if linked) have been removed or reset as necessary.

#### 5.4.2 **BOOST# OUTPUT PIN**

The UCS2112 provides a BOOST# output pin to compensate for voltage drops during high loads. The BOOST# pin is an active-low, open-drain output that would be connected to a resistor in the DC-DC Converter's feedback error voltage loop (see Figure 5-3).

BOOST# pin is asserted The when V<sub>BUS</sub> Current > I<sub>BOOST</sub>. I<sub>BOOST</sub> typical value is 1.9A. The BOOST# is OR'ed for both  $V_{BUS1}$  and  $V_{BUS2}$  ports. When the BOOST# pin is asserted, it will remain in this state for at least  $t_{\text{BOOST}\ \text{MAT}}$  (minimum assertion time).





#### 5.5 **Discrete Input Pins**

#### 5.5.1 COMM ILIM INPUT

The COMM ILIM input determines the communications mode, as shown in Table 7-1. This is also the hardware strap for MAX Current Limit.

#### 5.5.2 SMCLK

When operated in Stand-Alone mode, this pin should be tied to ground. When the UCS2112 is configured for SMBus communications, the SMCLK is the clock input.

#### 5.5.3 SMDATA

When used in Stand-Alone, this pin should be tied to ground.

When the UCS2112 is configured for SMBus communications, the SMDATA is the data input/output.

### 6.0 DETECT STATE

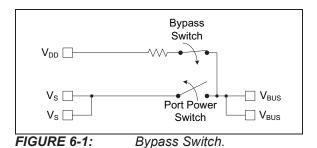
#### 6.1 Device Attach / Removal Detection

The UCS2112 can detect the attachment and removal of a portable device on the  $V_{BUS1}$  or  $V_{BUS2}$  ports.

Note:	By default, device attach / removal detec-						
	tion	tion feature is disabled. It can be enabled					
	by	clearing	ATT_D	DISABLE	bit	6	in
	Reg	gister 9-9.					

#### 6.1.1 V<sub>BUS</sub> BYPASS SWITCH

The UCS2112 contains circuitry to provide V<sub>BUS</sub> current as shown in Figure 6-1. In the Detect state, V<sub>DD</sub> is the voltage source; in the Active state, V<sub>S</sub> is the voltage source. The bypass switch and the port power switch are never both on at the same time.



While the V<sub>BUS</sub> bypass switch is active, the current available to a portable device will be limited to  $I_{BUS\_BYP}$  and the Attach Detection feature will be active.

#### 6.1.2 ATTACH DETECTION

The primary Attach Detection feature is only active in the Detect power state. When active, this feature constantly monitors the current load on the  $V_{BUS1}$  or  $V_{BUS2}$  pins. If the current drawn by a portable device is greater than  $I_{DET_QUAL}$  for longer than  $t_{DET_QUAL}$ , an Attach Detection event occurs. This will cause the A\_DET# Status bits to be set.

Until the port power switch is enabled, the current available to a portable device will be limited to that used to detect device attachment ( $I_{DET_QUAL}$ ). Once an Attach Detection event occurs, the UCS2112 will wait for the PWR\_EN control to be enabled (if not already). When PWR\_EN is enabled and V<sub>S</sub> is above the threshold, the UCS2112 will activate the V<sub>BUS</sub> port power switch and operate in Active state.

#### 6.1.3 REMOVAL DETECTION

The Removal Detection feature will be active in the Active and Detect power states. This feature monitors the current load on the  $V_{BUS1}$  and  $V_{BUS2}$  pins. If this load drops to less than  $I_{REM\_QUAL\_DET}$  for longer than  $t_{REM\_QUAL}$ , a Removal Detection event is flagged.

When a Removal Detection event is flagged, the following will be done:

- 1. Disable the port power switch and the bypass switch.
- 2. Set the REM Status register bit.
- Enable an internal discharging device that will discharge the V<sub>BUS</sub> line within t<sub>DISCHARGE</sub>.
- Once the V<sub>BUS</sub> pin has been discharged, the device will return to the Detect state regardless of the PWR\_EN control state.

NOTES:

### 7.0 USB PORT POWER SWITCH

To assure compliance to various charging specifications, the UCS2112 contains a USB port power switch that supports two current-limiting modes: Trip and Constant current (variable slope). The current limit ( $I_{LIM}$ ) is pin selectable (and may be updated via the register set). The switch also includes soft start circuitry and a separate short-circuit current limit.

The port power switch is on in the Active state (except when  $V_{\text{BUS}}$  is discharging).

**Note:** If a load that draws between 2 mA and 7 mA is connected to the port power switch, a voltage ripple between 40-90 mV<sub>PP</sub> is observed at the  $V_{BUS}$  output. This behavior is normal and it does not affect the charging process when a portable device is connected.

### 7.1 Current Limiting

#### 7.1.1 CURRENT LIMIT SETTING

The UCS2112 hardware set current limit,  $I_{LIM}$ , can be one of eight values. This resistor value is read once upon UCS2112 power-up. The current limit can be changed via the SMBus/I<sup>2</sup>C after power-up; however, the programmed current limit cannot exceed the hardware set current limit. Unless connected to V<sub>DD</sub>, the resistors in Table 7-1 are pull-down resistors.

At power-up, the communication mode (Stand-alone or SMBus/ $l^2$ C) and hardware current limit (I<sub>LIM</sub>) are determined via the pull-down resistor (or pull-up resistor if connected to V<sub>DD</sub>) on the COMM\_ILIM pin, as shown in Table 7-1.

#### 7.1.2 SHORT-CIRCUIT OUTPUT CURRENT LIMITING

Short-circuit current limiting occurs when the output current is above the selectable current limit ( $I_{LIMx}$ ). This event will be detected and the current will immediately be limited (within  $t_{SHORT\_LIM}$  time). If the condition remains, the port power switch will flag an Error condition and enter the Error state.

#### 7.1.3 SOFT START

When the PWR\_EN control changes states to enable the port power switch, or an Attach Detection event occurs in the Detect power state and the PWR\_EN control is already enabled, the UCS2112 invokes a soft start routine for the duration of the V<sub>BUS</sub> rise time ( $t_{R_BUS}$ ). This soft start routine will limit current flow from V<sub>S</sub> into V<sub>BUS</sub> while it is active. This circuitry will prevent current spikes due to a step in the portable device current draw.

In the case when a portable device is attached while the PWR\_EN pin is already enabled, if the bus current exceeds  $I_{LIM}$ , the UCS2112 current limiter will respond within a specified time ( $t_{SHORT\_LIM}$ ) and will operate normally at this point. The  $C_{BUS}$  capacitor will deliver the extra current, if any, as required by the load change.

TABLE 7-1:	ILIM DECODE

TADLE /-I.					
COMM_ILIM Pull Down Resistor (±1%)	PWR_EN1 and PWR_EN2 Polarity	I <sub>LIM</sub> (A)	Total I <sub>LIM</sub> (A) (Note 1)		
GND	Active-High	0.53	0.53 + 0.53		
10 kΩ	Active-High	0.96	0.96 + 096		
12 kΩ	Active-High	1.07	1.07 + 1.07		
15 kΩ	Active-High	1.28	1.28 + 1.28		
18 kΩ	Active-High	1.6	1.6 + 1.6		
22 kΩ	Active-High	2.13	2.13 + 2.13		
27 kΩ	Active-High	2.67	2.67 + 2.67		
33 kΩ	Active-High	3.2	3.2 + 3.2		
47 kΩ	Active-Low	0.53	0.53 + 0.53		
56 kΩ	Active-Low	0.96	0.96 + 0.96		
68 kΩ	Active-Low	1.07	1.07 + 1.07		
82 kΩ	Active-Low	1.28	1.28 + 1.28		
100 kΩ	Active-Low	1.6	1.6 + 1.6		
120 kΩ	Active-Low	2.13	2.13 + 2.13		
150 kΩ	Active-Low	2.67	2.67 + 2.67		
V <sub>DD</sub>	Active-Low	3.2	3.2 + 3.2		
<b>Note 1:</b> The total maximum current depends on power dissipation characteristics of the design (see Table 1-1).					
7 1 4 CURRENT LIMITING MODES					

#### 7.1.4 CURRENT LIMITING MODES

The UCS2112 current limiting has two modes: trip and constant current (variable slope). Either mode functions at all times when the port power switch is closed. When operating in the Detect power state, the current capacity at  $V_{BUS}$  is limited to  $I_{BUS_BYP}$  as described in **Section 6.1.1 "VBUS Bypass Switch"**.

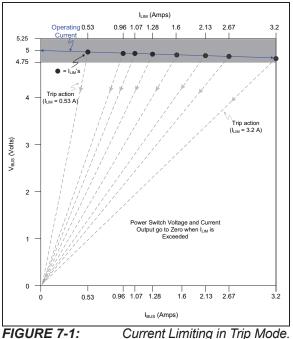
#### 7.1.4.1 Trip Mode

When using trip current limiting, the UCS2112 USB port power switch functions as a low resistance switch and rapidly turns off if the current limit is exceeded. While operating using trip current limiting, the  $V_{BUS}$  output voltage will be held relatively constant (equal to the  $V_S$  voltage minus the  $R_{ON} \times I_{BUS}$  current) for all current values up to the  $I_{LIM}$ .

If the current drawn by a portable device exceeds  ${\rm I}_{\rm LIM},$  the following occurs:

- 1. The port power switch will be turned off (Trip action).
- 2. The UCS2112 will enter the Error state and assert the ALERT# pin.
- 3. The fault handling circuitry will then determine subsequent actions.

Figure 7-1 shows operation of current limits in trip mode with the shaded area representing the USB 2.0 specified V<sub>BUS</sub> range. Dashed lines indicate the port power switch output will go to zero (e.g., trip) when I<sub>LIM</sub> is exceeded. Note that operation at all possible values of I<sub>LIM</sub> are shown in Figure 7-1 for illustrative purposes only; in actual operation only one I<sub>LIM</sub> can be active at any time.



## 7.1.4.2 Constant Current Limiting (Variable Slope)

Constant current limiting is used when the current drawn is greater than  $I_{LIM}$  (and  $I_{LIM} \leq$  1.6A). In CC mode, the port power switch allows the attached portable device to reduce  $V_{BUS}$  output voltage to less than the input  $V_S$  voltage while maintaining current delivery. The V/I slope depends on the user set  $_{ILIM}$  value. This slope is held constant for a given  $I_{LIM}$  value.

This mode is specifically provided for devices that rely on resistive means to reduce  $V_{BUS}$  voltage for direct battery charging or to allow portable devices a means to "test" charger capacity. See Figure 7-2.

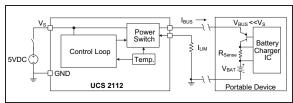


FIGURE 7-2:

Constant Current Example.

Figure 7-3 shows operation of current limits while using CC mode. Unlike trip mode, once  $I_{BUS}$  current exceeds  $I_{LIM}$ , operation continues at a reduced voltage and increased current. Note that the shaded area representing the USB 2.0 specified  $V_{BUS}$  range is now restricted to an upper current limit of  $I_{BUS}$ \_R2MIN. Note that the UCS2112 will heat up along each load line as voltage decreases. If the internal temperature exceeds the  $T_{REG}$  or  $T_{TSD}$  thresholds, the port power switch will open. Also note that when the  $V_{BUS}$  voltage is brought low enough (below  $V_{BUS}$ \_MIN), the port power switch will open.

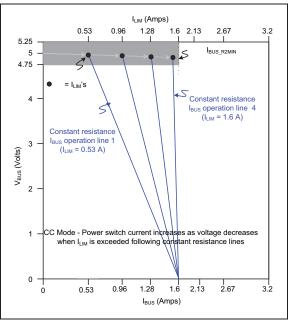


FIGURE 7-3: Current Limiting in CC Mode.

#### 7.2 USB Port Power Profiles

The UCS2112 combines the qualities of traditional USB port power switches with USB port power profiles set forth in the USB-IF BC1.2 specification. USB port power profiles consist of distinct voltage-current operation regions defined by "keep-out" and "operation" regions.

While operating in CC mode, the UCS2112 provides voltage-current output operating profiles that are specified by two keep-out regions.

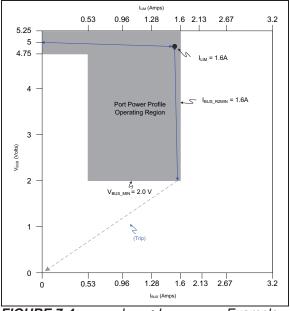
If the current reaches the  $I_{BUS\_R2MIN}$  setting for longer than  $t_{MASK}$ , the UCS2112 enters the Error state and an Overcurrent event is flagged.

If the V<sub>BUS</sub> voltage ever goes below the no operation lower-voltage keep-out (V<sub>BUS\_MIN</sub>) value for longer than  $t_{MASK}$ , the port power switch is disabled and a keep-out violation is flagged (by setting the MIN\_KEEP\_OUT Status bit). This will cause the device to enter the Error state.

Figure 7-4 illustrates the relationship between these USB port power profile parameters.

#### 7.2.1 OPERATION WITHIN A USB PORT POWER PROFILE

An attached device may be constrained to operate within the boundaries of a USB port power profile by setting the value of  $I_{LIM}$  less than the USB port power profile  $I_{BUS\_R2MIN}$  value. In this case, the port power switch will be in Trip mode up until  $I_{LIM}$  is exceeded. At which point, the switch will transition into CC mode. If the attached device reduces the output voltage to less than  $V_{BUS\_MIN}$ , the switch will trip and terminate charging.

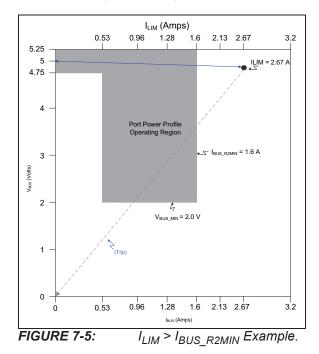


**FIGURE 7-4:**  $I_{LIM} < I_{BUS_{R2MIN}}$  Example.

The CC mode of operation is possible only				
up to 1.6A. As long as the value of $I_{LIM}$ is				
less than the fixed port power profile				
I <sub>BUS R2MIN</sub> value, CC mode is possible.				
Otherwise, the USB port power switch will				
operate in trip mode operation.				

## 7.2.2 OPERATION OUTSIDE OF A USB PORT POWER PROFILE

An attached device may be allowed to operate outside of the boundaries of a USB port power profile by setting the value of  $I_{LIM}$  greater than the USB port power profile  $I_{BUS\_R2MIN}$  value. This is the default operation for all portable devices. In this case, the USB port power switch will operate in Trip mode until the bus current reaches the  $I_{LIM}$  value. Once the  $I_{LIM}$  value has been exceeded, the port power switch will open and terminate charging. Figure 7-5 illustrates an example of current limiting in this configuration.



#### 7.3 Thermal Management and Voltage Protection

#### 7.3.1 THERMAL MANAGEMENT

The UCS2112 utilizes two-stage internal thermal management. The first stage is Dynamic Thermal Management, and the second stage is Fixed Thermal Shutdown.

#### 7.3.1.1 Dynamic Thermal Management

For the first stage (active in both current-limiting modes), referred to as Dynamic Thermal Management, the UCS2112 automatically adjusts port power switch limits and modes to lower power dissipation when the thermal regulation temperature value is approached, as described in this section.

If the internal temperature exceeds the  $T_{REG}$  value, the port power switch is opened, the current limit ( $I_{LIM}$ ) will be lowered by one step and a timer is started ( $t_{DC\_TEMP}$ ). When this timer expires, the port power switch is closed and the internal temperature will be checked again. If it remains above the  $T_{REG}$  threshold, the UCS2112 will repeat this cycle (open port power switch and reduce the  $I_{LIM}$  setting by one step) until  $I_{LIM}$  reaches its minimum value.

If the UCS2112 is operating using Constant Current Limiting (variable slope) and the I<sub>LIM</sub> setting has been reduced to its minimum set point and the temperature is still above  $T_{REG}$ , the UCS2112 will switch to operating using trip current limiting. This will be done by reducing the I<sub>BUS\_R2MIN</sub> setting to 100 mA and restoring the I<sub>LIM</sub> setting to the value immediately below the programmed setting (e.g., if the programmed I<sub>LIM</sub> is 2.13A, the value will be set to 1.6A). If the temperature continue this cycle (open the port power switch and reduce the I<sub>LIM</sub> setting by one step).

If the UCS2112 internal temperature drops below  $T_{REG}$  -  $T_{REG\_HYST}$ , the UCS2112 will take action based on the following:

- If the Current Limit mode changed from CC mode to Trip mode, then a timer is started. When this timer expires, the UCS2112 will reset the port power switch operation to its original configuration, allowing it to operate using Constant Current Limiting (variable slope).
- 2. If the Current Limit mode did not change from CC mode to Trip mode, or was already operating in Trip mode, the UCS2112 will reset the port power switch operation to its original configuration.

If the UCS2112 is operating using Trip Current Limiting and the I<sub>LIM</sub> setting has been reduced to its minimum set point and the temperature is above T<sub>REG</sub>, the port power switch will be closed and the current limit will be held at its minimum setting until the temperature drops below T<sub>REG</sub> - T<sub>REG</sub> HYST.

#### 7.3.1.2 Thermal Shutdown

The second stage of thermal management consists of a hardware implemented thermal shutdown corresponding to the maximum allowable internal die temperature (T<sub>TSD</sub>). If the internal temperature exceeds this value, the port power switches (both ports) will immediately be turned off until the temperature is below T<sub>TSD</sub> - T<sub>TSD\_HYST</sub>.

#### 7.4 V<sub>BUS</sub> Discharge

The UCS2112 will discharge  $V_{BUS}$  through an internal  $100\Omega$  resistor when at least one of the following conditions occurs:

- The PWR\_EN control is disabled (triggered on the inactive edge of the PWR\_EN control).
- A portable device Removal Detection event is flagged if the Attach/Removal Detect feature is enabled (by default it is disabled).
- The  $V_S$  voltage drops below a specified threshold  $(V_{S\_UVLO})$  that causes the port power switch to be disabled.
- When commanded into the Sleep power state.
- Upon recovery from the Error state.
- When commanded via the SMBus in the Active state.
- Any time the port power switch is activated after the V<sub>BUS</sub> bypass switch has been on (i.e., whenever V<sub>BUS</sub> voltage transitions from being driven from V<sub>DD</sub> to being driven from V<sub>S</sub>, such as going from Detect to Active power state) if the Attach/Removal Detect feature is enabled (by default it is disabled).
- Any time the V<sub>BUS</sub> bypass switch is activated after the port power switch has been on (i.e., going from Active to Detect power state) if the Attach/Removal Detect feature is enabled (by default it is disabled).

When the V<sub>BUS</sub> discharge circuitry is activated at the end of the t<sub>DISCHARGE</sub> time, the UCS2112 will confirm that V<sub>BUS</sub> was discharged. If the V<sub>BUS</sub> voltage is not below the V<sub>TEST</sub> level, a discharge error will be flagged (by setting the DISCH\_ERR(1/2) Status bit) and the UCS2112 will enter the Error state.

#### 7.5 Charge Rationing Interactions

When charge rationing is active, regardless of the specified behavior, the UCS2112 will function normally until the charge rationing threshold is reached. Note that charge rationing is only active when the UCS2112 is in the Active state, and it does not automatically reset when a Removal or Attach Detection event occurs. This allows charging of sequential portable devices while charge is being rationed, which means that the accumulated power given to several portable devices will still be held to the stated rationing limit.

Changing the charge rationing behavior will have no effect on the charge rationing data registers. If the behavior is changed prior to reaching the charge rationing threshold, this change will occur and be transparent to the user. When the charge rationing threshold is reached, the UCS2112 will take action as shown in Table 7-2. If the behavior is changed after the charge rationing threshold has been reached, the UCS2112 will immediately adopt the newly programmed behavior, clearing the ALERT# pin and restoring switch operation respectively (see Table 7-4).

	RTN_BEH (1 or 2) <1:0> Behavior		Actions taken	Notes	
1	0				
0	0	Report	ALERT# pin asserted.		
0	1	Report and Disconnect (default)	<ol> <li>ALERT# pin asserted.</li> <li>Port power switch disconnected.</li> </ol>	All bus monitoring is still active. Toggling the PWR_EN control will cause the device to change power states as defined by the registers; however, the port power switch will remain off until the rationing circuitry is reset. Fur- thermore, the bypass switch will not be turned on if enabled via the Attach Detection.	
1	0	Disconnect and Go to Sleep	<ol> <li>Port power switch dis- connected.</li> <li>Device will enter the Sleep state.</li> </ol>	All $V_{BUS}$ and $V_{S}$ monitoring will be stopped. Toggling the PWR_EN control will have no effect on the power state until the rationing circuitry is reset.	
1	1	Ignore	Take no further action.		

TABLE 7-2: CHARGE RATIONING BEHAVIOR

#### TABLE 7-3:CHARGE RATIONING RESET BEHAVIOR

Behavior	Reset Actions
Report	1. Reset the Total Accumulated Charge registers.
	2. Clear the RATION Status bit.
	3. Release the ALERT# pin.
Report and Disconnect	1. Reset the Total Accumulated Charge registers.
	2. Clear the RATION Status bit.
	3. Release the ALERT# pin.
	<ol> <li>Check the PWR_EN controls and enter the indicated power state if the controls changed.</li> </ol>
Disconnect and	1. Reset the Total Accumulated Charge registers.
Go to Sleep	2. Clear the RATION Status bit.
	<ol> <li>Check the PWR_EN controls and enter the indicated power state if the controls changed.</li> </ol>
Ignore	1. Reset the Total Accumulated Charge registers.
	2. Clear the RATION Status bit.

Previous Behavior	New Behavior	Actions Taken					
Ignore	Report	Assert ALERT# pin.					
	Report and Disconnect	<ol> <li>Assert ALERT# pin.</li> <li>Open port power switch. See the Report and Disconnect (default) in Table 7-2.</li> </ol>					
	Disconnect and Go to Sleep	<ol> <li>Open port power switch.</li> <li>Enter the Sleep state. See the Disconnect and Go to Sleep in Table 7-2.</li> </ol>					
Report	Ignore	Release ALERT# pin.					
	Report and Disconnect	Open port power switch. See the Report and Disconnect (default) in Table 7-2.					
	Disconnect and Go to Sleep	<ol> <li>Release the ALERT# pin.</li> <li>Open the port power switch.</li> <li>Enter the Sleep state. See the Disconnect and Go to Sleep in Table 7-2.</li> </ol>					
Report and Disconnect	Ignore	<ol> <li>Release the ALERT# pin.</li> <li>Check the PWR_EN controls and enter the indicated power state if the controls changed.</li> </ol>					
	Report	Check the PWR_EN controls and enter the indicated power state if the control changed.					
	Disconnect and Go to Sleep	<ol> <li>Release the ALERT# pin.</li> <li>Enter the Sleep state. See the Disconnect and Go to Sleep in Table 7-2.</li> </ol>					
Disconnect and go to	Ignore	Check the PWR_EN controls and enter the indicated power state if the controls changed.					
Sleep	Report	<ol> <li>Assert the ALERT# pin.</li> <li>Check the PWR_EN controls and enter the indicated power state if the controls changed.</li> </ol>					
	Report and Disconnect	<ol> <li>Assert the ALERT# pin.</li> <li>Check the PWR_EN controls to determine the power state then enter that state except that the port power switch and bypass switch will not be closed.</li> </ol>					

#### TABLE 7-4: EFFECTS OF CHANGING RATIONING BEHAVIOR AFTER THRESHOLD REACHED

If the RTN\_EN control is set to '0' prior to reaching the charge rationing threshold, rationing will be disabled and the Total Accumulated Charge registers will be cleared. If the RTN\_EN control is set to '0' after the charge rationing threshold has been reached, the following additional steps occur:

- 1. RATION Status bit will be cleared.
- 2. The ALERT# pin will be released if asserted by the rationing circuitry and no other conditions are present.
- 3. The PWR\_EN controls are checked to determine the power state.

Setting the RTN\_RST control to '1' will automatically reset the Total Accumulated Charge registers to 00\_00h. If this is done prior to reaching the charge rationing threshold, the data will continue to be accumulated restarting from 00\_00h. If this is done after the charge rationing threshold is reached, the UCS2112 will take action as shown in Table 7-3.

#### 7.6 Fault Handling Mechanism

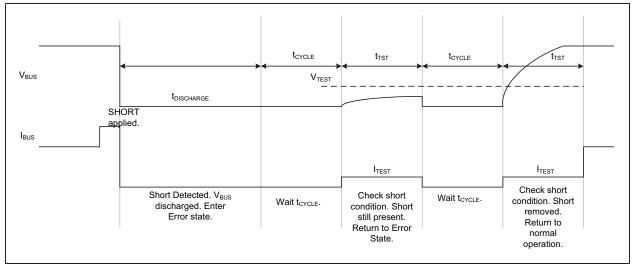
The UCS2112 has two modes for handling faults:

- Latch (latch-upon-fault)
- Auto-recovery (automatically attempt to restore the Active power state after a fault occurs).

If the SMBus is actively utilized, auto-recovery fault handling is the default error handler as determined by the LATCH\_SET bit. Faults include overcurrent, overvoltage (on  $V_S$ ), undervoltage (on  $V_{BUS}$ ), back-voltage ( $V_{BUS}$  to  $V_S$  or  $V_{BUS}$  to  $V_{DD}$ ), discharge error, and maximum allowable internal die temperature ( $T_{TSD}$ ) exceeded. Faults do not include keep-out violations except  $V_{BUS}$  MIN.

#### 7.6.1 AUTO-RECOVERY FAULT HANDLING

When the LATCH\_SET bit is low, auto-recovery fault handling is used. When an error condition is detected, the UCS2112 will immediately enter the Error state and assert the ALERT# pin. Independently from the host controller, the UCS2112 will wait a preset time ( $t_{CYCLE}$ ), check error conditions ( $t_{TST}$ ), and restore Active operation if the error condition(s) no longer exist. If all other conditions that may cause the ALERT# pin to be asserted have been removed, the ALERT# pin will be released. A short-circuit auto-recovery example is provided in Figure 7-6.



#### FIGURE 7-6: Error Recovery.

#### 7.6.2 LATCHED FAULT HANDLING

When the LATCH\_SET bit is high, latch fault handling is used. When an error condition is detected, the UCS2112 will enter the Error power state and assert the ALERT# (1 or 2) pin. Upon command from the host controller (by toggling the PWR\_EN (1, or 2) pin control from enabled to disabled or by clearing the ERR bit via SMBus), the UCS2112 will check error conditions once and restore Active operation if error conditions no longer exist. If an error condition still exists, the host controller is required to issue the command again to check error conditions.

If the ALERT# pin is asserted and the Interrupt Status registers (addresses 03h or 04h) are not read, the corresponding ALERT# pin remains asserted until the corresponding PWR\_EN pin is toggled.

If the ALERT# pin is asserted and the Interrupt Status registers are read, the ALERT# pin will deassert, but the UCS will remain in error state until the ERR bit is cleared via SMBus or the PWR EN pin is toggled.

### 8.0 SYSTEM MANAGEMENT BUS PROTOCOL

In SMBus mode, the UCS2112 communicates with a host controller, such as an Microchip PIC<sup>®</sup> microcontroller or hub, through the SMBus. The SMBus is a two-wire serial communication protocol between a computer host and its peripheral devices. A detailed timing diagram is shown in Figure 1-1. Stretching of the SMCLK signal is supported; however, the UCS2112 will not stretch the clock signal.

#### 8.1 SMBus Start Bit

The SMBus Start bit is defined as a transition of the SMBus Data line from a logic '1' state to a logic '0' state while the SMBus Clock line is in a logic '1' state.

#### 8.2 SMBus Address and RD/WR Bit

The SMBus Address Byte consists of the 7-bit client address followed by the RD/WR indicator bit. If this RD/WR bit is a logic '0', the SMBus Host is writing data to the client device. If this RD/WR bit is a logic '1', the SMBus Host is reading data from the client device.

The UCS2112 with the order code UCS2112-1-V/G4 has the SMBus address  $57h - 1010_{111}(r/w)$ .

Customers should contact their distributor, representatives or field application engineer (FAE) for additional SMBus addresses. Local sales offices are also available to help customers. A list of sales offices and locations is included in the back of this document.

#### 8.3 SMBus Data Bytes

All SMBus Data bytes are sent Most Significant bit first and composed of 8 bits of information.

#### 8.4 SMBus ACK and NACK Bits

The SMBus client will acknowledge all data bytes that it receives. This is done by the client device pulling the SMBus Data line low after the 8th bit of each byte that is transmitted. This applies to both the Write Byte and Block Write protocols.

The Host will NACK (not acknowledge) the last data byte to be received from the client by holding the SMBus data line high after the 8th data bit has been sent. For the Block Read protocol, the Host will ACK (acknowledge) each data byte that it receives except the last data byte.

#### 8.5 SMBus Stop Bit

The SMBus Stop bit is defined as a transition of the SMBus Data line from a logic '0' state to a logic '1' state while the SMBus clock line is in a logic '1' state. When the UCS2112 detects an SMBus Stop bit and it has been communicating with the SMBus protocol, it will reset its client interface and prepare to receive further communications.

#### 8.6 SMBus Time-out

The UCS2112 includes an SMBus time-out feature. If the clock is held at logic '0' for  $t_{TIMEOUT}$ , the device can time out and reset the SMBus interface. The SMBus interface can also reset if both the clock and data lines are held at a logic '1' for  $t_{IDLE\_RESET}$ . Communication is restored with a Start condition.

The time-out function defaults to disabled. It can be enabled by clearing the DIS\_TO bit in the General Configuration 3 register (see Register 9-9).

### 8.7 SMBus and I<sup>2</sup>C Compliance

The major difference between SMBus and  $I^2C$  devices is highlighted in this section. For complete compliance information, refer to the SMBus 2.0 specification and Application Note AN14.0 "*Microchip Dedicated Slave Devices in I*<sup>2</sup>*C Systems*" (DS00001853).

- UCS2112 supports I<sup>2</sup>C fast mode at 400 kHz. This covers the SMBus maximum time of 100 kHz.
- The minimum frequency for SMBus communications is 10 kHz.
- The client protocol will reset if the clock is held low longer than 30 ms. This time-out functionality is disabled by default in the UCS2112 and can be enabled by clearing the DIS\_TO bit. I<sup>2</sup>C does not have a time out.
- Except when operating in Sleep, the client protocol will reset if both the clock and the data line are logic '1' for longer than 200  $\mu$ s (Idle condition). This function is disabled by default in the UCS2112 and can be enabled by clearing the DIS\_TO bit. I<sup>2</sup>C does not have an Idle condition.
- I<sup>2</sup>C devices do not support the Alert Response Address functionality (which is optional for SMBus).
- I<sup>2</sup>C devices support block read and write differently. I<sup>2</sup>C protocol allows for unlimited number of bytes to be sent in either direction. The SMBus protocol requires that an additional data byte indicating number of bytes to read/write is transmitted. The UCS2112 supports I<sup>2</sup>C formatting only.

#### 8.8 SMBus Protocols

The UCS2112 is SMBus 2.0-compatible and supports Send Byte, Read Byte, Block Read, Receive Byte as valid protocols as shown below. The UCS2112 also supports the I<sup>2</sup>C block read and block write protocols. The device supports Write Byte, Read Byte, and Block Read/Block Write. All of the below protocols use the convention in Table 8-1.

Data Sent to Device	Data Sent to the Host
Data sent	Data sent

#### 8.9 SMBus Write Byte

The Write Byte is used to write one byte of data to a specific register as shown in Table 8-2.

START	Slave Address	WR	ACK	Reg. Addr.	АСК	Register Data	АСК	STOP
$1 \rightarrow 0$	YYYY_YYY	0	0	XXh	0	XXh	0	$0 \rightarrow 1$

#### 8.10 SMBus Read Byte

The Read Byte protocol is used to read one byte of data from the registers as shown in Table 8-3.

TABLE 8-3: READ BYTE PROTOCOL

START	Slave Address	WR	ACK	Register Address	ACK	
$1 \rightarrow 0$	YYYY_YYY	0	0	XXh	0	
START	Slave Address	RD	ACK	Register Data	NACK	STOP
$1 \rightarrow 0$	YYYY_YYY	1	0	XXh	1	$0 \rightarrow 1$

#### 8.11 Block Write

The Block Write is used to write multiple data bytes to a group of contiguous registers, as shown in Table 8-4. It is an extension of the Write Byte Protocol.

TABLE 8-4: BLOCK WRITE PROTOCOL

ſ	START	Slave Address	WR ACK		Register	АСК	Repeat N Ti	mes	STOP
	START	Slave Address	VVIX	ACK	Address	AUN	Register Data	ACK	310F
ľ	$1 \rightarrow 0$	YYYY_YYY	0	0	XXh	0	XXh	0	$0 \rightarrow 1$

#### 8.12 Block Read

The Block Read is used to read multiple data bytes from a group of contiguous registers, as shown in Table 8-5. It is an extension of the Read Byte Protocol.

TABLE 8-5:BLOCK READ PROTOCOL

START	Slave Address	WR	ACK	Register Address ACK						
$1 \rightarrow 0$	YYYY_YYY	0	0	XXh	0					
START	Slave Address	RD	АСК	Repeat N Times		<b>Repeat N Times</b>		Register Data	NACK	STOP
JIANI	Slave Address	ND	ACK	Register Data	ACK	Register Data	MACK	310P		
$1 \rightarrow 0$	YYYY_YYY	1	0	XXh	0	XXh	1	$0 \rightarrow 1$		

Note: The Block Write and Block Read protocols require that the Address Pointer be automatically incremented. For a write command, the Address Pointer will be automatically incremented when the ACK is sent to the host. There are no over or under bound limit checking and the Address Pointer will wrap around from FFh to 00h if necessary.

#### 8.13 SMBus Send Byte

The Send Byte protocol is used to set the internal address register pointer to the correct address location. No data is transferred during the Send Byte protocol as shown in Table 8-6.

Note 1:	The SMBus Send Byte command is
	expected to be followed by the SMBus
	Receive Byte command. When two
	SMbus Send Byte commands are sent in
	a row, the first command receives an ACK
	and will be processed by the UCS2112,
	but the second command receives a
	NACK, and will be ignored.

#### TABLE 8-6: SEND BYTE PROTOCOL

START	Slave Address	WR	ACK	Register Address	ACK	STOP
$1 \rightarrow 0$	YYYY_YYY	0	0	XXh	0	$0 \rightarrow 1$

#### 8.14 SMBus Receive Byte

The Receive Byte protocol is used to read data from a register when the internal register Address Pointer is known to be at the right location (e.g., set via Send Byte). This is used for consecutive reads of the same register as shown in Table 8-7.

#### TABLE 8-7: RECEIVE BYTE PROTOCOL

START	Slave Address	RD	ACK	Register Data	NACK	STOP
$1 \rightarrow 0$	YYYY_YYY	1	0	XXh	1	$0 \rightarrow 1$

#### 8.14.1 STAND-ALONE OPERATING MODE

Stand-alone mode allows the UCS2112 to operate without active SMBus/l<sup>2</sup>C communications. Stand-alone mode can be enabled by connecting a pull-down resistor greater or equal to 47 k $\Omega$  on the COMM\_ILIM pin as shown in Table 5-3.The SMCLK pin should be tied to ground in this mode.

# 9.0 **REGISTER DESCRIPTION**

The registers shown in Table 9-1 are accessible through the SMBus or I<sup>2</sup>C. An entry of '—' indicates that the bit is not used. Writing to these bits will have no effect and reading these bits will return '0'. Writing to a reserved bit may cause unexpected results and reading from a reserved bit will return either '1' or '0' as indicated in the bit description. While in the Sleep state, the UCS2112 will retain configuration and charge rationing data as indicated in the text. If a register does not indicate that data will be retained in the Sleep power state, this information will be lost when the UCS2112 enters the Sleep power state.

Register Address	Register Name	R/W	Function	Default Value	Page No.
00h	Port 1 Current Measurement	R	Stores the current measurement for port 1	00h	38
01h	Port 2 Current Measurement	R	Stores the current measurement for port 2	00h	38
02h	V <sub>BUS</sub> Port Status	R	Indicates Load Share V <sub>BUS</sub> Port and general status	00h	39
03h	Interrupt Status1	See Text	Indicates why ALERT# pin asserted for port 1	00h	40
04h	Interrupt Status2	See Text	Indicates why ALERT# pin asserted for port 2	00h	42
0Fh	General Status1	R/R-C	Indicates General Status for port 1	00h	44
10h	General Status2	R/R-C	Indicates General Status for port 2	00h	45
11h	General Configuration1	R/W	Controls basic functionality for port 1	06h	46
12h	General Configuration2	R/W	Controls basic functionality for port 2	02h	47
13h	General Configuration3	R/W	Controls other functionality	60h	48
14h	Current Limit	R/W	Controls/Displays MAX Current Limit per port	00h	49
15h	Auto-Recovery Configuration	R/W	Controls the auto-recovery functionality	2Ah	50
16h	Port 1 Total Accumulated Charge High Byte	R	Stores the total accumulated charge delivered high byte, Port 1	00h	51
17h	Port 1 Total Accumulated Charge Middle High Byte	R	Stores the total accumulated charge delivered middle high byte, Port 1	00h	51
18h	Port 1 Total Accumulated Charge Middle Low Byte	R	Stores the total accumulated charge delivered middle low byte, Port 1	00h	51
19h	Port 1 Total Accumulated Charge Low Byte	R	Stores the total accumulated charge delivered low byte, Port 1	00h	51
1Ah	Port 2 Total Accumulated Charge High Byte	R	Stores the total accumulated charge delivered high byte, Port 2	00h	52
1Bh	Port 2 Total Accumulated Charge Middle High Byte	R	Stores the total accumulated charge delivered middle high byte, Port 2	00h	52
1Ch	Port 2 Total Accumulated Charge Middle Low Byte	R	Stores the total accumulated charge delivered middle low byte, Port 2	00h	52
1Dh	Port 2 Total Accumulated Charge Low Byte	R	Stores the total accumulated charge delivered low byte, Port 2	00h	52
1Eh	Port 1 Charge Rationing Threshold High Byte	R/W	Sets the maximum allowed charge that will be delivered to Port 1	FFh	53
1Fh	Port 1 Charge Rationing Threshold Low Byte	R/W	Sets the maximum allowed charge that will be delivered to Port 1	FFh	53
20h	Port 2 Charge Rationing Threshold High Byte	R/W	Sets the maximum allowed charge that will be delivered to Port 2	FFh	53

 TABLE 9-1:
 REGISTER SET IN HEXADECIMAL ORDER

Register Address	Register Name	R/W	Function	Default Value	Page No.
21h	Port 2 Charge Rationing Threshold Low Byte	R/W	Sets the maximum allowed charge that will be delivered to Port 2	FFh	53
22h	Ration Configuration	R/W	Controls Charge Ration Functionality	11h	54
23h	Port 1 Current Limit Behavior	R/W	Controls the Current Limiting Behavior (CC Mode Region 2) for Port 1	96h	55
24h	Port 2 Current Limit Behavior	R/W	Controls the Current Limiting Behavior (CC Mode Region 2) for Port 2	96h	55
FDh	Product ID	R	Stores a fixed value that identifies each product	E1h	56
FEh	Manufacturer ID	R	Stores a fixed value that identifies Microchip	5Dh	56
FFh	Revision	R	Stores a fixed value that represents the revision number	81h	56

#### TABLE 9-1: REGISTER SET IN HEXADECIMAL ORDER (CONTINUED)

#### 9.1 Current Measurement Register

The Current Measurement register stores the measured current value delivered to the portable device ( $I_{BUS}$ ). This value is updated continuously while the device is in the Active power state.

#### REGISTER 9-1: PORTS 1 AND 2 CURRENT MEASUREMENT REGISTERS (ADDRESSES 00H, 01H)

R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
			CM(x)	<7:0>			
bit 7							bit 0
Legend:							

Legenu.			
R = Readable bit	W = Writable bit	U = Unimplemented bit	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7:0 **CM(x)<7:0>:** Port X Current Measurement, where x = 1 or 2 (address 00h for Port 1 and address 01h for Port 2) <sup>(1) (2)</sup>.

Note 1: The bit weights are in mA,1 LSB = 13.3 mA (maximum value is 255 LSB corresponding to 3.4A).

2: This data will be cleared when the device enters the Sleep or Detect states. This data will also be cleared whenever the port power switch is turned off (or any time that V<sub>BUS</sub> is discharged).

# 9.2 Status Registers

The Status registers store bits that indicate error conditions as well as Attach Detection and Removal Detection.

# REGISTER 9-2: V<sub>BUS</sub> PORT STATUS REGISTER (ADDRESS 02H)

R-0	R-0	R-0	R-0	U-0	U-0	R-0	R-0
ALERT2_PIN	ALERT1_PIN	CC_MODE2	CC_MODE1	_	—	ADET2_PIN	ADET1_PIN
bit 7							bit 0

Legend:				
R = Readable	bit	W = Writable bit	U = Unimplemented bi	t
-n = Value at P	OR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown
bit 7	changes states 1 = ALERT#2		LERT#2 pin. This bit is set a	nd cleared as the ALERT#2 pin
bit 6	changes states 1 = ALERT#1		LERT#1 pin. This bit is set a	nd cleared as the ALERT#1 pin
bit 5	1 = Port 2 in C	Port2 Constant Current Mo constant Current mode rating normally	de State	
bit 4	1 = Port 1 in C	Port1 Constant Current Mo Constant Current mode rating normally	de State	
bit 3-2	Unimplemente	ed		
bit 1			_DET#2 pin. When set, indies the A_DET#2 pin changes	cates that the A_DET#2 pin is states.
		pin is asserted (logic low) pin is not asserted		
bit 0	asserted low. T 1 = A_DET#1		_DET#1 pin. When set, indic s the A_DET#1 pin change:	cates that the A_DET#1 pin is s states.

R/W-0	R/C-0	R/C-0	R/C-0	R/C-0	R/C-0	R/C-0	R/C-0
ERR1 <sup>(1)</sup>	DISCH_ERR1	RESET	KEEP_OUT1	TSD	OV_VOLT	BACK_V1	OV_LIM1
bit 7					•	•	bit (
Legend:							
R = Readabl	le bit	W = Writable	bit	U = Unimpler	mented bit	C = Clear on	Read
-n = Value at	t POR	'1' = Bit is se	t	'0' = Bit is cle	ared	x = Bit is unk	nown
bit 7	<b>ERR1:</b> Error Po Error state. Wri Active state. W removed, the U the Error state i leave the Error	ting this bit to hen written to CS2112 retur is entered. If a	'0' will clear the '0', all error con ns to the Active	Error state an ditions are che state. This bit	d allows the devecked. If all erro	vice to be retur r conditions ha ally by the UC	rned to the ave been S2112 when
	(Note 1). 1 = Port 1 in E	nditions are de rror State.		e, this bit is clea	recovery fault ha ared when the P		
bit 6	DISCH_ERR1: be cleared whe cause the ALE	Discharge En n read if the e RT#1 pin to be was unable to	or Port 1 – indic rror condition has asserted and t discharge V <sub>BUS</sub>	ates the device as been remov he device to e	ved or if the ERF	R bit is cleared	
bit 5		<ol> <li>This bit is closerted when the sected when the sected is a sected when the sected</li></ol>	eared when reans bit is set. Thi	d or when the	d should be re-p PWR_EN contri ned in the Sleep	ol is toggled. T	
bit 4	<b>KEEP_OUT1:</b> I dropped below if the ERR1 bit i Error state. $1 = V_{BUS1} < V_{F}$	V <sub>BUS_MIN.</sub> Thi s cleared. This	s bit will be clea	red when read	l if the error con	dition has bee	n removed o
	$0 = V_{BUS1} > V_{I}$						
bit 3		ered the Error e ERR1 bit is to enter the E hutdown Temp	state. This bit w cleared. This bit rror state. perature reache	vill be cleared will cause the	when read if the	error condition	n has been
	0 = Internal ter						
bit 2	<b>OV_VOLT:</b> V <sub>S</sub> device has enter removed or if th and the device	ered the Error e ERR1 bit is o	state. This bit w cleared. This bit	vill be cleared v	when read if the	error condition	n has been
	$1 = V_{S} > V_{S_{O}}$						
	$0 = V_{S} < V_{S} O'$						

# REGISTER 9-3: INTERRUPT STATUS 1 REGISTER (ADDRESS 03H)

#### REGISTER 9-3: INTERRUPT STATUS 1 REGISTER (ADDRESS 03H) (CONTINUED)

- bit 1 **BACK\_V1:** Back-Bias Voltage Port 1 Indicates that the  $V_{BUS1}$  voltage has exceeded the  $V_S$  or  $V_{DD}$  voltages by more than 150 mV. This bit will be cleared when read if the error condition has been removed or if the ERR1 bit is cleared. This bit will cause the ALERT#1 pin to be asserted and the device to enter the Error state.
  - 1 =  $V_{BUS1} > V_S$ , or  $V_{BUS1} > V_{DD}$  by more than 150 mV.
  - $0 = V_{BUS1}$  voltage has not exceeded the V<sub>S</sub> and V<sub>DD</sub> voltages by more than 150 mV.
- bit 0 **OV\_LIM1:** Overcurrent Limit Port 1 Indicates that the  $I_{BUS}$  current has exceeded both the  $I_{LIM}$  threshold and the  $I_{BUS_R2MIN}$  threshold settings for  $V_{BUS1}$ . This bit will be cleared when read if the error condition has been removed or if the ERR1 bit is cleared. This bit will cause the ALERT#1 pin to be asserted and the device to enter the Error state.
  - 1 = Current Limit for Port 1 exceeded
  - 0 = Current Limit for Port 1 not exceeded
- **Note 1:** Note that the ERR1 bit does not necessarily reflect the ALERT#1 pin status. The ALERT#1 pin may be cleared or asserted without the ERR1 bit changing states.

R/W-0	R/C-0	R-0	R/C-0	R/C-0	U-0	R/C-0	R/C-0
ERR2 <sup>(1)</sup>	DISCH_ERR2	VS_LOW	KEEP_OUT2	TREG	_	BACK_V2	OV_LIM2
bit 7					1		bit
Legend:	lo hit	M = M/ritoblo	hit	II – Unimplom	optod bit	C = Clear on	Road
R = Readable bit -n = Value at POR		W = Writable		U = Unimplem			
n = value a	POR	'1' = Bit is set	[	'0' = Bit is clea	ared	x = Bit is unk	nown
bit 7	Error state. Wri Active state. Wri removed, the U the Error state is leave the Error functionality is a PWR_EN2 con 1 = Port 2 in E	ting this bit to hen written to ICS2112 return is entered. If a state. This bit i active and no trol is disabled rror State.	es that an error v a '0' will clear th '0', all error con ns to the Active ny other bit is se s cleared autom error conditions d (Note 1).	e Error state and ditions are che state. This bit is et in the Interru atically by the L are detected. L	nd allows the cked. If all err s set automat pt Status regi JCS2112 if the	device to be ret or conditions ha ically by the UC ster (04h), the d e auto-recovery	urned to the ive been S2112 wher evice will no fault handlin
bit 6	DISCH_ERR2: be cleared whe	Discharge Err n read if the e RT#2 pin to be as unable to di	or Port 2 – indica rror condition ha asserted and the scharge V <sub>BUS2</sub> .	ates the device as been remove	ed or if the EF	RR bit is cleared	
bit 5	$V_{BUS2}$ port pow the $V_{S\_UVLO}$ the	ver switches ai reshold. has fallen bel	V <sub>S</sub> voltage has f re held off. This ow the V <sub>S_UVLO</sub> JVLO.	bit is cleared a	-		
bit 4	dropped below	V <sub>BUS_MIN.</sub> Thi is cleared. This BUS_MIN	m Keep-out regi s bit will be clea s bit will cause th	red when read	if the error co	ndition has bee	n removed o
bit 3	current limit has	s been reduce to be asserted nperature > T		ared when read	d and will not		
bit 2	Unimplemente	ed: Read as '0	'				
bit 1	BACK_V2: Bac voltages by more	ck-Bias Voltag	e Port 2 – Indica	ates that the V <sub>P</sub>	<sub>US2</sub> voltage h	as exceeded th	e V <sub>S</sub> or V <sub>DD</sub>

## REGISTER 9-4: INTERRUPT STATUS 2 REGISTER (ADDRESS 04H)

0 =  $V_{BUS2}$  voltage has not exceeded the  $V_S$  and  $V_{DD}$  voltages by more than 150 mV.

#### REGISTER 9-4: INTERRUPT STATUS 2 REGISTER (ADDRESS 04H) (CONTINUED)

- bit 0 **OV\_LIM2:** Overcurrent Limit Port 2 Indicates that the  $I_{BUS}$  current has exceeded both the  $I_{LIM}$  threshold and the  $I_{BUS_R2MIN}$  threshold settings for  $V_{BUS2}$ . This bit will be cleared when read if the error condition has been removed or if the ERR2 bit is cleared. This bit will cause the ALERT#2 pin to be asserted and the device to enter the Error state.
  - 1 = Current Limit for Port 2 exceeded
  - 0 = Current Limit for Port 2 not exceeded.
- **Note 1:** Note that the ERR2 bit does not necessarily reflect the ALERT#2 pin status. The ALERT#2 pin may be cleared or asserted without the ERR2 bit changing states.

R/C-0	U-x	U-x	R-0	R-0	R/C-0	R/C-0	R-0
RATION1	—	_	CC_MODE1	PWR_EN1_CON	LOW_CUR1	REM1	ADET1
bit 7	·	•	·			•	bit
Legend:							
R = Readab	ole bit	W = Writab	le bit	U = Unimplemente	ed bit	C = Clear on	Read
-n = Value a	at POR	'1' = Bit is s	set	'0' = Bit is cleared		x = Bit is unk	nown
bit 7	when the R <sup>-</sup> 1 = Port 1 h	TN_RST1 bit nas delivered	is set or the RTI	tioning. This bit is cl N_EN1 bit is cleared d mAh of current imed mAh of currer	d.	ad, or cleared	automatically
bit 6-5	Unimpleme						
bit 4			hether Port 1 ha	as entered CC mod	e.		
	1 = Port 1 is in CC mode 0 = Port 1 not in CC mode						
bit 3	logic expres		EN1 pin OR PW is set	control state. This b R_EN1S).	oit is set and cle	eared automat	tically with the
bit 2	V <sub>BUS1</sub> and r to be assert	may have finis ed if the ALE					
			ent above thres				
bit 1	longer a por ALERT#1 p		present on the V ted.	tes if a Removal De ' <sub>BUS1</sub> pin. This bit is			
		noval Detection					
bit 0	pins and the		ortable device p	es that an Attach De resent. Asserts the			
		Detection eve ch Detection		. A_DET#1 pin ass	erted		

# REGISTER 9-5: GENERAL STATUS 1 REGISTER (ADDRESS 0FH)

R/C-0	U-x	U-x	R-0	R-0	R/C-0	R/C-0	R-0
RATION2	—	_	CC_MODE2	PWR_EN2_COM	LOW_CUR2	REM2	ADET2
bit 7				• •			bit
Legend:							
R = Readab	le bit	W = Writabl	e bit	U = Unimplemer	nted bit	C = Clear or	n Read
-n = Value a	t POR	'1' = Bit is s	et	'0' = Bit is cleare		x = Bit is unl	known
bit 7	when the R 1 = Port 2 h	TN_RST2 bit in as delivered	s set or the RTI	tioning. This bit is N_EN2 bit is clear d mAh of current med mAh of curre	ed.	ad, or clearec	l automatically
bit 6-5	Unimpleme		ea are program				
bit 4	CC_MODE2: Indicates whether Port 2 has entered CC mode. 1 = Port 2 is in CC mode 0 = Port 2 not in CC mode						
bit 3	logic expres 1 = Port 2 F		EN2 pin OR. PV is set	control state. This VR_EN2S).	bit is set and cle	eared automa	tically with the
bit 2	V <sub>BUS2</sub> and r to be assert 1 = Port 2	nay have finis ed if the ALEF charging curre		reshold			
bit 1	longer a por ALERT#2 pi 1 = Remova		resent on the V ted. ccurred	tes if a Removal D B <sub>US1</sub> pin. This bit			
bit 0	pins and the as the A_DE 1 = Attach I	ere is a new po ET#2 pin char	ortable device p ges. nt has occurred	es that an Attach I resent. Asserts th . A_DET#2 pin as	e A_DET#2 pin		

# REGISTER 9-6: GENERAL STATUS 2 REGISTER (ADDRESS 10H)

# 9.3 Configuration Registers

The Configuration registers control basic device functionality. The contents of these registers are retained in Sleep.

#### REGISTER 9-7: GENERAL CONFIGURATION 1 REGISTER (ADDRESS 11H)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-1	R/W-1	R/W-0
ALERT1_MASK	ALERT1_LINK	DSCHG1	PWR_EN1S	DISCHG_	TIME<1:0>	ATT_TI	H1<1:0>
bit 7 bit 0							

Legend:			
R = Readable b	bit W = Writable bit	U = Unimplemented bit	C = Clear on Read
-n = Value at P	OR '1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown
bit 7	ALERT1_MASK: Mask errors for all inte		/_LIM1 and TSD.
	<ul> <li>1 = The ALERT#1 pin will only assert if a</li> <li>0 = The ALERT#1 pin will be asserted if</li> </ul>		vent is detected.
bit 6	ALERT1_LINK: Links the ALERT#1 pin		
	1 = The ALERT#1 pin will be asserted if		
	0 = The ALERT#1 pin will not be asserted	—	
bit 5	<b>DSCHG1:</b> Forces the V <sub>BUS1</sub> to be reset a Writing this bit to a logic '1' will cause the		
	to activate and discharge V <sub>BUS</sub> . Actual d bit is self-clearing.		
	1 = V <sub>BUS1</sub> discharge initiated. 0 = Port 1 not in discharge		
bit 4	<b>PWR_EN1S:</b> Power Enable Port 1 overri polarity is set to active-high, either the PV switch.		
bit 3-2	DISCHG_TIME<1:0>: Discharge time Po same for both ports.	ort 1 – sets t <sub>DISCHARGE</sub> . The disc	charge time value is the
	00 = 100 ms		
	01 = 200 ms 10 = 300 ms		
	11 = 400  ms		
bit 1-0	ATT_TH1<1:0>: Attach Detection Thresh mine an Attach event has occurred. It als		
	00 = 200 μA Attach/100 μA Removal		
	01 = 400 μA Attach/300 μA Removal 10 = 800 μA Attach/700 μA Removal		
	$11 = 1000 \ \mu\text{A} \text{Attach/900} \ \mu\text{A} \text{Removal}$		
	removal threshold is different when operatir ect power state.	ng in the Active power state vers	sus when operating in the

	OLIVEINAL					•/	
R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-1	R/W-0
ALERT2_MASK	ALERT2_LINK	DSCHG2	PWR_EN2S	_	_	ATT_T	H2<1:0>
bit 7				·			bit
Legend:							
R = Readable bit		W = Writable	bit	U = Unimple	mented bit	C = Clear c	on Read
-n = Value at POR	R	'1' = Bit is set		'0' = Bit is cl	eared	x = Bit is ur	nknown
bit 7	ALERT2_MASK 1 = The ALERT 0 = The ALERT	#2 pin will only	y assert if a OV	_LIM2 or TSD	is detected.	-	
bit 6	ALERT2_LINK: 1 = The ALERT 0 = The ALERT	#2 pin will be	asserted if the l	_OW_CUR2 d	r TREG indic	ator bit is se	t.
	<b>DSCHG2:</b> Force Writing this bit to to activate to dis is self-clearing.	a logic '1' will	cause the port p	ower switch to	o be opened a	and the disch	narge circuitr
	$1 = V_{BUS2} \text{ disch}$ 0 = Port 2 not in	-					
	<b>PWR_EN2S:</b> Popolarity is set to a switch.						
bit 3-2	Unimplemented	b					
	ATT_TH2<1:0>: mine an Attach e 00 = 200 μA Atta 01 = 400 μA Atta 10 = 800 μA Atta 11 = 1000 μA Atta	event has occι ach/100 μΑ Re ach/300 μΑ Re ach/700 μΑ Re	urred. It also co emoval emoval emoval				
Note 1: The rer	moval threshold i	is different whe	en operating in	the Active pov	ver state vers	sus when ope	erating in th

#### REGISTER 9-8: GENERAL CONFIGURATION 2 REGISTER (ADDRESS 12H)

**Note 1:** The removal threshold is different when operating in the Active power state versus when operating in the Detect power state.

R/W-0	R/W-1	R/W-1	R-0	R-0	R/W-0	U-0	U-0
PIN_IGN	ATT_DIS	DIS_TO	PWR_ST	ATE<1:0> <sup>(1)</sup>	BOOST		—
bit 7	ŀ					·	bit 0
Legend:							
R = Readab	ole bit	e bit W = Writable bit U = Unimplemented bit		C = Clear on Read			
-n = Value a	It POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unk	nown
bit 7 bit 6	<pre>is retained in S 1 = PWR_EN 0 = Power sta and the co ATT_DIS: Atta power state (se enabled. 1 = Attach/Ret</pre>	leep. 1 and PWR_EN te is determined prresponding PV ch Detect Disat	2 pin states a d by the OR'd VR_EN1S and ole – Disables etting this bit t n disabled.	_EN2 pin states re ignored. combination of d PWR_EN2S b the Attach and o 1 forces Active	the PWR_EN it states. Removal Dete	1 and PWR_EI	N2 pins states
bit 5	<b>DIS_TO:</b> Disat 1 = Time out c 0 = Time out e	lisabled	Disables the S	MBus time out f	eature.		
bit 4-3	PWR_STATE< 00 = SLEEP 01 = DETECT 10 = ACTIVE 11 = ERROR		Power State –	These bits indic	ate the curren	t power state. S	See Note 1
bit 2	1 = I <sub>BUS</sub> has 0 = I <sub>BUS</sub> is les	exceeded I <sub>BOOS</sub> ss than I <sub>BOOST</sub> (	ST on either o		<sub>T</sub> on V <sub>BUS1</sub> or	V <sub>BUS2</sub> (bit is C	)R'ed).
bit 1-0	Unimplement	ed					
Note 1: A	Accessing the SM	IBus/I <sup>2</sup> C causes	the UCS211	2 to leave the SI	eep state. As	a result, the	

## REGISTER 9-9: GENERAL CONFIGURATION 3 REGISTER (ADDRESS 13H)

**Note 1:** Accessing the SMBus/I<sup>2</sup>C causes the UCS2112 to leave the Sleep state. As a result, the PWR\_STATE<1:0> bits will never read as 00b.

# 9.4 Current Limit Register

The Current Limit register controls the I<sub>LIM</sub> used by the port power switch. The default setting is based on the resistor on the COMM\_ILIM pin and this value cannot be changed to be higher than hardware set value. The contents of this register are retained in Sleep.

#### REGISTER 9-10: CURRENT LIMIT REGISTER (ADDRESS 14H)

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
	_	IL	ILIM_PORT2<2:0>			ILIM_PORT1<2:0>			
bit 7							bit 0		

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6 Unimplemented: Read as '0'

bit 5-3	ILIM_PORT2<2:0>: Sets the I <sub>LIM</sub> value for port 2.
	000 <b>= 0.53A</b>
	001 = 0.96A
	010 <b>= 1.07A</b>
	011 = 1.28A
	100 <b>= 1.6A</b>
	101 <b>= 2.13A</b>
	110 <b>= 2.67A</b>
	111 <b>= 3.2A</b>
	111 <b>-</b> 3.2A
bit 2-0	ILIM_SW<2:0>: Sets the I <sub>LIM</sub> value for port 1.
bit 2-0	
bit 2-0	<b>ILIM_SW&lt;2:0&gt;:</b> Sets the I <sub>LIM</sub> value for port 1.
bit 2-0	ILIM_SW<2:0>: Sets the I <sub>LIM</sub> value for port 1. 000 = 0.53A
bit 2-0	ILIM_SW<2:0>: Sets the I <sub>LIM</sub> value for port 1. 000 = 0.53A 001 = 0.96A
bit 2-0	ILIM_SW<2:0>: Sets the I <sub>LIM</sub> value for port 1. 000 = 0.53A 001 = 0.96A 010 = 1.07A
bit 2-0	ILIM_SW<2:0>: Sets the I <sub>LIM</sub> value for port 1. 000 = 0.53A 001 = 0.96A 010 = 1.07A 011 = 1.28A
bit 2-0	ILIM_SW<2:0>: Sets the I <sub>LIM</sub> value for port 1. 000 = 0.53A 001 = 0.96A 010 = 1.07A 011 = 1.28A 100 = 1.6A

#### 9.5 Auto-Recovery Register

The contents of this register are retained in Sleep.

The Auto-Recovery Configuration register sets the parameters used when the auto-recovery fault handling algorithm is invoked. Once the auto-recovery fault handling algorithm has checked the overtemperature and back-drive conditions, it will set the I<sub>LIM</sub> value to I<sub>TEST</sub> and then turn on the port power switch and start the t<sub>TST</sub> timer. If, after the timer has expired, the V<sub>BUS</sub> voltage is less than V<sub>TEST</sub>, then it is assumed that a short-circuit condition is present and the Error state is restarted for auto recovery.

#### REGISTER 9-11: AUTO RECOVERY CONFIGURATION REGISTER (ADDRESS 15H)

R/W-0	R/W-0	R/W-1	R/W-0	R/W-1	R/W-0	R/W-1	R/W-0
LATCHS		TCYCLE<2:0>		TTST	<1:0>	VTST_S	SW<1:0>
bit 7	•						bit 0
Legend: R = Readab	lo hit	W = Writable t	sit.		optod bit		
			Л	U = Unimplem			
-n = Value a	IPOR	'1' = Bit is set		'0' = Bit is clea	irea	x = Bit is unl	KNOWN
bit 7	detected.			ndling routine tha			
	must be	cleared by the us	ser.	the UCS2112 to when an error co			e, the ERR bit
bit 6-4		>: Defines the de rithm is started a		after the Error sta w.	te is entered b	efore the auto-	recovery fault
	110 = 45 ms 111 = 50 ms						
bit 3-2	1151<1:0>: 1 00 = 10 ms 01 = 15 ms 10 = 20 ms 11 = 25 ms	≺etry Duration ti	ner – Sets the	e t <sub>TST</sub> as shown	DEIOW.		
bit 1-0		short removed.	ge Threshold '	V <sub>TEST</sub> voltage th	reshold that m	ust be crossed	during retries

## 9.6 Total Accumulated Charge Registers

The Total Accumulated Charge registers store the total accumulated charge delivered from the V<sub>S</sub> source to a portable device. The bit weighting of the registers is given in mA-hrs. The register value is reset to  $00_00h$  only when the RTN\_RST bit is set or if the RTN\_EN bit is cleared (see Register 9-16). This value will be retained when the device transitions out of the Active state and resumes accumulation if the device returns to the Active state and charge rationing is still enabled.

These registers are updated every one (1) second while the UCS2112 is in the Active power state. Every time the value is updated, it is compared against the target value in the Charge Rationing Threshold registers. This data is retained in the Sleep state.

# REGISTER 9-12: PORT1 TOTAL ACCUMULATED CHARGE REGISTERS (ADDRESS 16H, 17H, 18H, 19H)

R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
			TA	C1<25:18>			
bit 31							bit 24
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
			TA	C1<17:10>			
bit 23							bit 16
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
			T,	AC1<9:2>			
bit 15							bit 8
R-0	R-0	U-0	U-0	U-0	U-0	U-0	U-0
TAC1	<1:0>	—	—	—	_	—	_
bit 7							bit 0
Legend:							
R = Readabl	e bit	W = Writable b	bit	U = Unimplem	nented bit		
-n = Value at POR		'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkn	iown

bit 31-6TAC1<25:0>: Total Accumulated Charge Port 1 – Each LSB of this 26-bit value equals 0.00367 mAh.bit 5-0Unimplemented: Read as '0'

# REGISTER 9-13: PORT2 TOTAL ACCUMULATED CHARGE REGISTER (ADDRESS 1AH,1BH,1CH,1DH)

R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
			TAC	2<25:18>			
bit 31							bit 24
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
			TAC	2<17:10>			
bit 23							bit 16
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
			TA	C2<9:2>			
bit 15							bit 8
R-0	R-0	U-0	U-0	U-0	U-0	U-0	U-0
TAC2	<1:0>	—	—	—	—	—	_
bit 7		· · ·					bit (
Legend:							
R = Readable bit W = Write		W = Writable b	it	U = Unimplem	ented bit		
-n = Value at POR '1' = Bit is set		'1' = Bit is set		'0' = Bit is cleared x = Bit is unkno			

bit 31-6 **TAC2<25:0>:** Total Accumulated Charge Port 2 – Each LSB of this 26-bit value equals 0.00367 mAh. bit 5-0 **Unimplemented:** Read as '0'

# 9.7 Charge Rationing Threshold Registers

The Charge Rationing Threshold registers set the maximum allowed charge that will be delivered to a portable device. Every time the Total Accumulated Charge registers are updated, the value is checked against this limit. If the value meets or exceeds this limit, the RATION1/RATION2 bit is set and action taken according to the RTN\_BEH1<1:0> and RTN\_BEH2<1:0> bits in Register 9-16: Ration Configuration Register (Address 22h).

#### REGISTER 9-14: PORT 1 CHARGE RATIONING THRESHOLD REGISTERS (ADDRESS 1EH,1FH)

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
			С	T1<15:8>			
bit 15							bit 8
R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
			(	CT1<7:0>			
bit 7							bit 0
Legend:							
R = Readable bit W = Writable bit			U = Unimplem	ented bit			
-n = Value at POR (1' = Bit is set			'0' = Bit is cleared x = Bit is unknown			n	

bit 15-0 **CT1<15:0>:** Charge Rationing Threshold Port 1 – Each LSB of this 16-bit value equals 3.76 mAh.

#### REGISTER 9-15: PORT 2 CHARGE RATIONING THRESHOLD REGISTERS (ADDRESS 20H, 21H)

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
			CT	2<15:8>			
bit 15							bit 8
R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
			C	[2<7:0>			
bit 7							bit 0
Legend:							

- <b>J</b>			
R = Readable bit	W = Writable bit	U = Unimplemented bit	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-0 **CT2:** Charge Rationing Threshold Port 2 – Each LSB of this 16-bit value equals 3.76 mAh.

R/W-0	R/W-0	R/W-0	R/W-1	R/W-0	R/W-0	R/W-0	R/W-1				
RTN_EN2	RTN_RST2	1	H2<1:0>	RTN EN1	RTN RST1		EH1<1:0>				
bit 7							bit 0				
Legend:											
R = Readabl		W = Writable b	bit	U = Unimplem							
-n = Value at	POR	'1' = Bit is set		'0' = Bit is cleared x = Bit is unknow							
bit 7	RTN EN2: Ch	arge Ration En	able Port 2 – E	nables Charge I	Rationing for Po	ort 2.					
	<ul> <li>RTN_EN2: Charge Ration Enable Port 2 – Enables Charge Rationing for Port 2.</li> <li>1 = Charge Rationing enabled</li> <li>0 = Charge Rationing disabled. The Total Accumulated Charge registers for port 2 will be cleared to 00_00h and current data will no longer be accumulated. If the Total Accumulated Charge registers have already reached the Charge Rationing Threshold, the applied response will be removed as if the charge rationing had been reset. This will also clear the RATION2 Status bit (if set).</li> </ul>										
bit 6	1 = Total Accu RATION2 ALERT#2	<ul> <li>the charge rationing had been reset. This will also clear the RATION2 Status bit (if set).</li> <li><b>RTN_RST2:</b> Port 2 Ration Reset – Resets the charge rationing functionality for port 2.</li> <li>1 = Total Accumulated Charge registers are reset to 00_00h. In addition, when this bit is set, the RATION2 Status bit will be cleared and, if there are no other errors or active indicators, the ALERT#2 pin will be released.</li> <li>0 = Normal operation. This bit must be cleared to enable charge rationing.</li> </ul>									
bit 5-4		been exceeded		its – Controls ho Table 7-2).	w the UCS2112	responds who	en the Ration				
bit 3	1 = Charge Ra 0 = Charge Ra 00_00h ar have alrea	ationing enabled ationing disabled and current data ady reached the	d d. The Total A will no longer b Charge Ratior	nables Charge I ccumulated Cha e accumulated. ning Threshold, i s will also clear	arge registers fo If the Total Accord the applied resp	or port 1 will umulated Cha oonse will be i	arge registers removed as if				
bit 2	<ul> <li>the charge rationing had been reset. This will also clear the RATION1 Status bit (if set).</li> <li><b>RTN_RST1:</b> Port 1 Ration Reset – Resets the charge rationing functionality for port 1.</li> <li>1 = Total Accumulated Charge registers are reset to 00_00h. In addition, when this bit is set, RATION1 Status bit will be cleared and, if there are no other errors or active indicators, ALERT#1 pin will be released.</li> <li>0 = Normal operation. This bit must be cleared to enable charge rationing.</li> </ul>										
bit 1-0	_	been exceeded		its – Controls ho Table 7-2).	w the UCS2112	responds who	en the Ration				

# REGISTER 9-16: RATION CONFIGURATION REGISTER (ADDRESS 22H)

### 9.8 Current Limit Behavior Registers

The Current Limit Behavior register stores the values used by the applied current limiting mode (trip or CC). The contents of this register are not retained in Sleep.

#### REGISTER 9-17: PORT 1 CURRENT LIMIT BEHAVIOR REGISTER (ADDRESS 23H)

R/W-1 R/W-0	U-0	R/W-1	R/W-0	R/W-1	R/W-1	R/W-0
SEL_VBUS1_MIN<1:0>	—	SE	L_R2_IMIN1<2:	:0>	Reserved	Reserved
bit 7						bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6 **SEL\_VBUS1\_MIN<1:0>:** Define the V<sub>BUS\_MIN</sub> voltage for port 1 as follows:

00 = 1.50V 01 = 1.75V 10 = 2.0V 11 = 2.25V

#### bit 5 Unimplemented

bit 4-2 SEL\_R2\_IMIN1<2:0>: Defines the I<sub>BUS R2MIN</sub> current.

000 = 100 mA 001 = 530 mA 010 = 960 mA 011 = 1280 mA 100 = 1600 mA 101 = 2130 mA

bit 1-0 Reserved: Do not change.

#### REGISTER 9-18: PORT 2 CURRENT LIMIT BEHAVIOR REGISTER (ADDRESS 24H)

R/W-1	R/W-0	U-0	R/W-1	R/W-0	R/W-1	R/W-1	R/W-0
SEL_VBUS2_MIN<1:0> -		—	SEL_R2_IMIN2<2:0>			Reserved	Reserved
bit 7 bi						bit 0	

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6 SEL\_VBUS2\_MIN<1:0>: Define the V<sub>BUS MIN</sub> voltage for port 2 as follows:

	00 = 1.50V 01 = 1.75V 10 = 2.0V 11 = 2.27V
	11 = 2.25V
bit 5	Unimplemented
bit 4-2	SEL_R2_IMIN2<2:0>: Defines the I <sub>BUS_R2MIN</sub> current.
	000 <b>= 100 mA</b>
	001 <b>= 530 mA</b>
	010 <b>= 960 mA</b>
	011 <b>= 1280 mA</b>
	100 <b>= 1600 mA</b>
	101 <b>= 2130 mA</b>

bit 1-0 **Reserved**: Do not change.

#### 9.9 Product ID Register

The Product ID register stores a unique 8-bit value that identifies the UCS device family.

#### REGISTER 9-19: PRODUCT ID REGISTER (ADDRESS FDH)

R-1	R-1	R-1	R-0	R-0	R-0	R-0 F	R-1
			PID	<7:0>			
bit 7							bit 0
Legend:							
R = Readable	bit	W = Writable bit		U = Unimpleme	ented bit		
-n = Value at F	POR	'1' = Bit is set		'0' = Bit is clear	red	x = Bit is unknowr	ו

bit 7-0 **PID<7:0>:** Product ID for the UCS2112.

#### 9.10 Manufacturer ID Register

The Manufacturer ID register stores a unique 8-bit value that identifies Microchip Technology Inc.

#### REGISTER 9-20: MANUFACTURER ID REGISTER (ADDRESS FEH)

R-0	R-1	R-0	R-1	R-1	R-1	R-0	R-1
	MID<7:0>						
bit 7 bit 0							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 MID<7:0>: Manufacturer ID for Microchip.

#### 9.11 Revision Register

The Revision register stores an 8-bit value that represents the part revision.

#### REGISTER 9-21: REVISION REGISTER (ADDRESS FFH)

R-1	R-0	R-0	R-0	R-0	R-0	R-0	R-1
REV<7:0>							
bit 7 bit 0							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

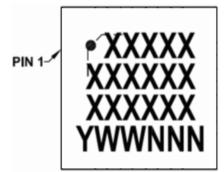
bit 7-0 **REV<7:0>:** Part Revision.

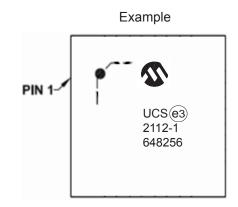
NOTES:

# **10.0 PACKAGING INFORMATION**

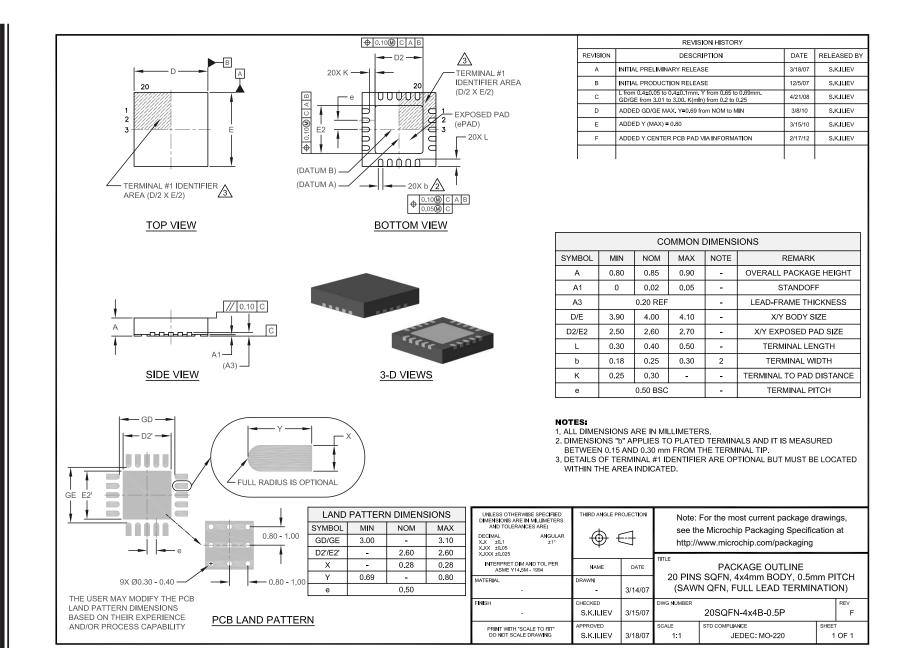
# 10.1 Package Marking Information

4x4 mm QFN, 20-lead





Legend	: XXX Y YY WW NNN (e3) *	Customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC <sup>®</sup> designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator ((3)) can be found on the outer packaging for this package.
	be carrie	nt the full Microchip part number cannot be marked on one line, it will d over to the next line, thus limiting the number of available s for customer-specific information.



© 2015 - 2017 Microchip Technology Inc.

**UCS2112** 

NOTES:

# APPENDIX A: REVISION HISTORY

# **Revision C (February 2017)**

The following is the list of modifications:

- Added minimum and maximum values for the ILIM7 parameter in Table 1-2: Electrical Specifications.
- Added "Operating Junction Temperature" parameter in Table 1-3: Temperature Specifications.
- Added a note in Section 8.13, SMBus Send Byte detailing the behavior of the UCS2112 when two commands are sent in a row.
- Added maximum value for the VDD\_TH\_HYST parameter and maximum value for the R<sub>ON\_PSW</sub> parameter in Table 1-2 Electrical Specifications.
- Updated Figure 2-8 "Detect State VBUS vs. IBUS".
- Minor typographical corrections

## **Revision B (October 2015)**

• Updated Features to indicate EN/IEC 60950-1 (CB) certification.

## **Revision A (August 2015)**

· Original release of this document

NOTES:

# **PRODUCT IDENTIFICATION SYSTEM**

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO. [	<u>x</u> ] <sup>(1)</sup> - <u>x</u> - <u>x</u> / <u>xx</u>		Examples:
Device Tape a			a) UCS2112-1-V/G4: Various Temperature 20-pin 4x4 QFN package
Option Range			b) UCS2112T-1-V/G4: Tape and Reel Various Temperature 20-pin 4x4 QFN Package
Device:	UCS2112: USB Dual-Port Power Switch and Current M	onitor	
Tape and Reel Option:	Blank = Tube T = Tape and Reel		
Version:	1 = SMBus address 57h		
Temperature Range:	V = $-40^{\circ}$ C to $+105^{\circ}$ C (Various)		<b>Note 1:</b> Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not
Package:	G4 = Plastic Quad Flat No Lead Package - 4x4 mm I with 0.40 mm Contact Length, Saw Singulated, 20-lead		fier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package availability with the Tape and Reel option.

NOTES:

#### Note the following details of the code protection feature on Microchip devices:

- · Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION, QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights unless otherwise stated.

Microchip received ISO/TS-16949:2009 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEELOQ® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001:2000 certified.

# QUALITY MANAGEMENT SYSTEM CERTIFIED BY DNV = ISO/TS 16949=

#### Trademarks

The Microchip name and logo, the Microchip logo, AnyRate, dsPIC, FlashFlex, flexPWR, Heldo, JukeBlox, KeeLoq, KeeLoq logo, Kleer, LANCheck, LINK MD, MediaLB, MOST, MOST logo, MPLAB, OptoLyzer, PIC, PICSTART, PIC32 logo, RightTouch, SpyNIC, SST, SST Logo, SuperFlash and UNI/O are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

ClockWorks, The Embedded Control Solutions Company, ETHERSYNCH, Hyper Speed Control, HyperLight Load, IntelliMOS, mTouch, Precision Edge, and QUIET-WIRE are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Analog-for-the-Digital Age, Any Capacitor, AnyIn, AnyOut, BodyCom, chipKIT, chipKIT logo, CodeGuard, dsPICDEM, dsPICDEM.net, Dynamic Average Matching, DAM, ECAN, EtherGREEN, In-Circuit Serial Programming, ICSP, Inter-Chip Connectivity, JitterBlocker, KleerNet, KleerNet logo, MiWi, motorBench, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, MultiTRAK, NetDetach, Omniscient Code Generation, PICDEM, PICDEM.net, PICkit, PICtail, PureSilicon, RightTouch logo, REAL ICE, Ripple Blocker, Serial Quad I/O, SQI, SuperSwitcher, SuperSwitcher II, Total Endurance, TSHARC, USBCheck, VariSense, ViewSpan, WiperLock, Wireless DNA, and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

Silicon Storage Technology is a registered trademark of Microchip Technology Inc. in other countries.

GestIC is a registered trademark of Microchip Technology Germany II GmbH & Co. KG, a subsidiary of Microchip Technology Inc., in other countries.

All other trademarks mentioned herein are property of their respective companies.

© 2015 - 2017, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.

ISBN: 978-1-5224-1382-0



# **Worldwide Sales and Service**

#### AMERICAS

Corporate Office 2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200 Fax: 480-792-7277 Technical Support: http://www.microchip.com/ support

Web Address: www.microchip.com

Atlanta Duluth, GA Tel: 678-957-9614 Fax: 678-957-1455

Austin, TX Tel: 512-257-3370

Boston Westborough, MA Tel: 774-760-0087 Fax: 774-760-0088

**Chicago** Itasca, IL Tel: 630-285-0071 Fax: 630-285-0075

**Dallas** Addison, TX Tel: 972-818-7423 Fax: 972-818-2924

**Detroit** Novi, MI Tel: 248-848-4000

Houston, TX Tel: 281-894-5983

Indianapolis Noblesville, IN Tel: 317-773-8323 Fax: 317-773-5453 Tel: 317-536-2380

Los Angeles Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608 Tel: 951-273-7800

Raleigh, NC Tel: 919-844-7510

New York, NY Tel: 631-435-6000

San Jose, CA Tel: 408-735-9110 Tel: 408-436-4270

**Canada - Toronto** Tel: 905-695-1980 Fax: 905-695-2078

#### ASIA/PACIFIC

Asia Pacific Office Suites 3707-14, 37th Floor Tower 6, The Gateway

Harbour City, Kowloon Hong Kong Tel: 852-2943-5100 Fax: 852-2401-3431

**Australia - Sydney** Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

**China - Beijing** Tel: 86-10-8569-7000 Fax: 86-10-8528-2104

**China - Chengdu** Tel: 86-28-8665-5511 Fax: 86-28-8665-7889

China - Chongqing Tel: 86-23-8980-9588 Fax: 86-23-8980-9500

China - Dongguan Tel: 86-769-8702-9880

China - Guangzhou Tel: 86-20-8755-8029

**China - Hangzhou** Tel: 86-571-8792-8115 Fax: 86-571-8792-8116

China - Hong Kong SAR Tel: 852-2943-5100

**China - Nanjing** Tel: 86-25-8473-2460 Fax: 86-25-8473-2470

Fax: 852-2401-3431

**China - Qingdao** Tel: 86-532-8502-7355 Fax: 86-532-8502-7205

**China - Shanghai** Tel: 86-21-3326-8000 Fax: 86-21-3326-8021

China - Shenyang Tel: 86-24-2334-2829 Fax: 86-24-2334-2393

**China - Shenzhen** Tel: 86-755-8864-2200 Fax: 86-755-8203-1760

**China - Wuhan** Tel: 86-27-5980-5300 Fax: 86-27-5980-5118

**China - Xian** Tel: 86-29-8833-7252 Fax: 86-29-8833-7256

### ASIA/PACIFIC

**China - Xiamen** Tel: 86-592-2388138 Fax: 86-592-2388130

**China - Zhuhai** Tel: 86-756-3210040 Fax: 86-756-3210049

India - Bangalore Tel: 91-80-3090-4444 Fax: 91-80-3090-4123

**India - New Delhi** Tel: 91-11-4160-8631 Fax: 91-11-4160-8632

India - Pune Tel: 91-20-3019-1500

**Japan - Osaka** Tel: 81-6-6152-7160 Fax: 81-6-6152-9310

**Japan - Tokyo** Tel: 81-3-6880- 3770 Fax: 81-3-6880-3771

**Korea - Daegu** Tel: 82-53-744-4301 Fax: 82-53-744-4302

Korea - Seoul Tel: 82-2-554-7200 Fax: 82-2-558-5932 or 82-2-558-5934

Malaysia - Kuala Lumpur Tel: 60-3-6201-9857 Fax: 60-3-6201-9859

Malaysia - Penang Tel: 60-4-227-8870 Fax: 60-4-227-4068

Philippines - Manila Tel: 63-2-634-9065 Fax: 63-2-634-9069

Singapore Tel: 65-6334-8870 Fax: 65-6334-8850

**Taiwan - Hsin Chu** Tel: 886-3-5778-366 Fax: 886-3-5770-955

Taiwan - Kaohsiung Tel: 886-7-213-7830

Taiwan - Taipei Tel: 886-2-2508-8600 Fax: 886-2-2508-0102

Thailand - Bangkok Tel: 66-2-694-1351 Fax: 66-2-694-1350

#### EUROPE

Austria - Wels Tel: 43-7242-2244-39 Fax: 43-7242-2244-393

**Denmark - Copenhagen** Tel: 45-4450-2828 Fax: 45-4485-2829

Finland - Espoo Tel: 358-9-4520-820

France - Paris Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

France - Saint Cloud Tel: 33-1-30-60-70-00

**Germany - Garching** Tel: 49-8931-9700 **Germany - Haan** Tel: 49-2129-3766400

Germany - Heilbronn Tel: 49-7131-67-3636

Germany - Karlsruhe Tel: 49-721-625370

**Germany - Munich** Tel: 49-89-627-144-0 Fax: 49-89-627-144-44

Germany - Rosenheim Tel: 49-8031-354-560

Israel - Ra'anana Tel: 972-9-744-7705

Italy - Milan Tel: 39-0331-742611 Fax: 39-0331-466781

Italy - Padova Tel: 39-049-7625286

Netherlands - Drunen Tel: 31-416-690399 Fax: 31-416-690340

Norway - Trondheim Tel: 47-7289-7561

Poland - Warsaw Tel: 48-22-3325737

Romania - Bucharest Tel: 40-21-407-87-50

**Spain - Madrid** Tel: 34-91-708-08-90 Fax: 34-91-708-08-91

Sweden - Gothenberg Tel: 46-31-704-60-40

Sweden - Stockholm Tel: 46-8-5090-4654

**UK - Wokingham** Tel: 44-118-921-5800 Fax: 44-118-921-5820

# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Microchip:

<u>UCS2112T-1-V/G4-V01</u> <u>UCS2112T-2-V/G4</u> <u>UCS2112-2-V/G4</u> <u>UCS2112-2-V/G4-V02</u> <u>UCS2112-1-V/G4-V01</u> <u>UCS2112T-1-V/G4</u> <u>UCS2112-1-V/G4</u> <u>UCS2112T-2-V/G4-V02</u>